

16-Bit, Low-Power Stereo Audio CODEC With Microphone Bias, Headphone, and Digital Speaker Amplifier

FEATURES

- Analog Front End:
 - Stereo Single-Ended Input With Multiplexer
 - Mono Differential Input
 - Stereo Programmable Gain Amplifier
 - Microphone Amplifier (20 dB) and Bias
- Analog Back End:
 - Stereo/Mono Line Output With Volume
 - Stereo/Mono Headphone Amplifier With Volume and Capless Mode
 - Stereo/Mono Digital Speaker Amplifier (BTL) With Volume
- Analog Performance:
 - Dynamic Range: 93 dB (DAC)
 - Dynamic Range: 90 dB (ADC)
 - 40-mW + 40-mW Headphone Output at $R_L = 16 \Omega$
 - 700-mW + 700-mW Speaker Output at $R_1 = 8 \Omega$
- Power Supply Voltage
 - 1.71 V to 3.6 V for Digital I/O Section
 - 1.71 V to 3.6 V for Digital Core Section
 - 2.4 V to 3.6 V for Analog Section
 - 2.4 V to 3.6 V for Power Amplifier Section
- Low Power Dissipation:
 - 7 mW in Playback, 1.8 V/2.4 V, 48 kHz
 - 13 mW in Record, 1.8 V/2.4 V, 48 kHz
 - 3.3 μW in Power Down
- Sampling Frequency: 5 kHz to 50 kHz
- Automatic Level Control for Recording
- Operation From a Single Clock Input Without PLL
- System Clock:
 - Common-Audio Clock (256 f_S/384 f_S), 12/24, 13/26, 13.5/27, 19.2/38.4, 19.68/39.36 MHz
- Headphone Plug Insert Detection

- 2 (I²C) or 3 (SPI) Wire Serial Control
- Programmable Function by Register Control:
 - Digital Attenuation of DAC: 0 dB to -62 dB
 - Digital Gain of DAC: 0, 6, 12, 18 dB
 - Power Up/Down Control for Each Module
 - 6-dB to –70-dB Gain for Analog Outputs
 - 30-dB to –12-dB Gain for Analog Inputs
 - 0/20 dB Selectable for Microphone Input
 - 0-dB to -21-dB Gain for Analog Mixing
 - Parameter Settings for ALC
 - Three-Band Tone Control and 3D Sound
 - High-Pass Filter: 4-, 120-, 240-Hz
 - Two-Stage Programmable Notch Filter
 - Analog Mixing Control
- Pop-Noise Reduction Circuit
- Short and Thermal Protection Circuit
- Package: 5-mm × 5-mm QFN Pacakge
- Operation Temperature Range: -40°C to 85°C

APPLICATIONS

- Portable Audio Player, Cellular Phone
- Video Camcorder, Digital Movie/Still Camera
- PMP/DMB

DESCRIPTION

The PCM3793A/94A is a low-power stereo CODEC designed for portable digital audio applications. The device integrates stereo digital speaker amplifier, headphone amplifier, line amplifier, line input, boost amplifier, microphone bias, programmable gain control, analog mixing, sound effects, and automatic level control (ALC). It is available in a small-footprint, 5-mm × 5-mm QFN package. The PCM3793A/94A supports right-justified, left-justified, l²S, and DSP formats, providing easy interfacing to audio DSP and decoder/encoder chips. Sampling rates up to 50 kHz are supported. The user-programmable functions are accessible through a two- or three-wire serial control port.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)(1)

	MAX	UNIT
Supply voltage V _{DD} , V _{IO} , V _{CC} , V _{PA}	-0.3 to 4	V
Ground voltage differences: DGND, AGND, PGND	±0.1	V
Input voltage	-0.3 to 4	V
Input current (any pins except supplies and SPK out) ±10		mA
Ambient temperature under bias	-40 to 110	°C
Storage temperature	-55 to 150	°C
Junction temperature	150	°C
Lead temperature (soldering)	260	°C, 5 s
Package temperature (reflow, peak)	260	°C

⁽¹⁾ Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute—maximum—rated conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

			MIN	NOM	MAX	UNIT
V_{CC} , V_{PA}	Analog supply voltage	nalog supply voltage				V
V_{DD}, V_{IO}	Digital supply voltage		1.71	3.3	3.6	V
	Digital input logic family	Digital input logic family		CMOS		
	Digital input clock fraguency	SCKI system clock	3.072		18.432	MHz
	Digital input clock frequency	LRCK sampling clock	8		48	kHz
		LOL and LOR	10			kΩ
	Analog output load resistance	HPOL and HPOR	16			Ω
		SPOLP, SPOLN, SPORP and SPORN	8			Ω
	Analog output load capacitance				30	pF
	Digital output load capacitance				10	pF
T _A	Operating free-air temperature		-40		85	°C



ELECTRICAL CHARACTERISTICS

All specifications at $T_A = 25$ °C, $V_{DD} = V_{IO} = V_{CC} = V_{PA} = 3.3$ V, $f_S = 48$ kHz, system clock = 256 f_S , and 16-bit data (unless otherwise noted).

	PARAMETER	TEST CONDITIONS	1 ONIST SSARTIB	PCM3793ARHB, PCM3794ARHB			
	TANAMETER	TEST CONDITIONS	MIN	MIN TYP MAX			
Audio Da	ata Characteristics						
DATA FO	ORMAT						
	Resolution			16	Bits		
	Audio data interface format		riç just	left-, ght- ified, SP			
	Audio data bit length			16	Bits		
	Audio data format		2	3 first, 2s lement			
	Sampling frequency (f _S)		5	50	kHz		
	0	V _{DD} < 2 V		27			
	System clock	V _{DD} > 2 V		40	MHz		
Digital Ir	nput/Output		1	,			
	Logic family		_	IOS patible			
V _{IH}	Input logic level		0.7 V _{IO}		VDC		
V _{IL}	input logic level			0.3 V _{IO}	VDC		
l _{iH}	Input logic current	V _{IN} = 3.3 V		10	^		
I _{IL}	input logic current	V _{IN} = 0 V		-10	μΑ		
V _{OH}	Output logic level	$I_{OH} = -2 \text{ mA}$	0.75 V _{IO}		VDC		
V _{OL}	Output logic level	I _{OL} = 2 mA		0.25 V _{IO}	VDC		
R _L = 10 k	nput to Line Output Through DAC $ \Omega $, ALC = OFF, volume = 0 dB, sp C PERFORMANCE	C (LOL, LOR, and MONO) eaker = powered down, analog mixing	= disabled				
	Full-scale output voltage	0 dB		2.828	Vp-p Vrms		
	Dynamic range	EIAJ, A-weighted		93	dB		
SNR	Signal-to-noise ratio	EIAJ, A-weighted	86	93	dB		
.	Channel separation			91	dB		
THD+N	Total harmonic distortion + noise	0 dB	(0.008%			
	Load resistance		10		kΩ		
Line Inp	ut to Line Output Through Mixing	Path (LOL, LOR, and MONO)					
R _L = 10 k	$\kappa\Omega$, ALC = OFF, volume = 0 dB, sp	eaker = powered down, analog mixing	= enabled				
DYNAMI	C PERFORMANCE						
	Full-scale input and output	0 dB		2.828	Vp-p		
	voltage			1	Vrms		



ELECTRICAL CHARACTERISTICS (continued)

All specifications at $T_A = 25$ °C, $V_{DD} = V_{IO} = V_{CC} = V_{PA} = 3.3$ V, $f_S = 48$ kHz, system clock = 256 f_S , and 16-bit data (unless otherwise noted).

	DADAMETED	TEST SOMBITIONS	PCM3793ARH	IB, PCM3794	ARHB	LINUT
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Digital I	nput to Headphone Output Throເ	igh DAC (HPOL and HPOR)				
R _L = 16	Ω or 32 Ω , ALC = OFF, volume = 0	dB, speaker = powered down, analog mi	xing = disabled, no	t capless mod	le	
DYNAM	IC PERFORMANCE					
	Full scale output voltage	0 dB		2.828		Vp-p
	Full-scale output voltage	О ИВ		1		Vrms
SNR	Signal-to-noise ratio	EIAJ, A-weighted	84	93		dB
TUD.N	Total harmonia distantian I naisa	30 mW, $R_L = 32 \Omega$, volume = 0 dB		0.1%		
THD+N	Total harmonic distortion + noise	40 mW, $R_L = 16 \Omega$, volume = $-1 dB$		0.03%		
	Load resistance		16			Ω
		200 Hz, 140 mVp-p		-40		
PSRR	Power-supply rejection ratio	1 kHz, 140 mVp-p		-45		dB
		20 kHz, 140 mVp-p		-32		
Line Inp	out to Headphone Output Through	n Mixing Path (HPOL and HPOR)	_+		·	
R _L = 16	Ω or 32 Ω , ALC = OFF, volume = 0	dB, speaker = powered down, analog mi	xing = enabled, not	t capless mod	e	
DYNAM	IC PERFORMANCE					
				2.828		Vp-p
	Full-scale output voltage	0 dB		1		Vrms
SNR	Signal-to-noise ratio	EIAJ, A-weighted	84	93		dB
	Load resistance	-	16			Ω
Digital I	nput to Speaker Output Through	DAC (SPOLP, SPOLN, SPORP, and SP	ORN): PCM3793A			
$R_1 = 8 \Omega$	2, ALC = OFF, volume = 0 dB, head	lphone = powered down, analog mixing =	disabled			
	IC PERFORMANCE					
				2.52		Vp-p
	Full-scale output voltage	0 dB		0.9		Vrms
SNR	Signal-to-noise ratio	EIAJ, A-weighted	84	93		dB
THD+N	Total harmonic distortion + noise	400 mW, $R_1 = 8\Omega$, volume = 0 dB		0.3%		
	Load resistance		8			Ω
		200 Hz, 140 mVp-p		-50		
PSRR	Power-supply rejection ratio	1 kHz, 140 mVp-p		-45		dB
	,,,,,	20 kHz, 140 mVp-p	-25			
Line Inp	out to Speaker Output Through M	ixing Path (SPOLP, SPOLN, SPORP, ar	nd SPORN): PCM3			
•		phone = powered down, analog mixing =	•			
	IC PERFORMANCE	, , , , , , , , , , , , , , , , , , , ,				
				2.52		Vp-p
	Full-scale output voltage	0 dB		0.9		Vrms
SNR	Signal-to-noise ratio	EIAJ, A-Weighted	84	93		dB
אווכ	Signal-to-noise fallo	EIAJ, A-Weignied	04	93		ub



ELECTRICAL CHARACTERISTICS (continued)

All specifications at $T_A = 25^{\circ}C$, $V_{DD} = V_{IO} = V_{CC} = V_{PA} = 3.3 \text{ V}$, $f_S = 48 \text{ kHz}$, system clock = 256 f_S , and 16-bit data (unless otherwise noted).

	PARAMETER	TEST CONDITIONS	PCM3793ARI	HB, PCM3794ARHB	UNIT	
	PARAMETER	TEST CONDITIONS	MIN	TYP MAX	UNII	
Line Inp	out to Digital Output Through AD	C (AIN1L/R, AIN2L/R, AIN3L, and AIN	13L/R)			
ALC = C	DFF, microphone boost = 0 dB, PG	A = 0 dB, speaker and headphone = po	wered down, analog	mixing = disabled		
DYNAM	IIC PERFORMANCE					
	Full scale input voltage	0 dB		2.828	Vp-p	
	Full-scale input voltage	0 dB		1	Vrms	
	Dynamic range	EIAJ, A-weighted		90	dB	
SNR	Signal-to-noise ratio	EIAJ, A-weighted	83	90	dB	
	Channel separation			87	dB	
THD+N	Total harmonic distortion + noise	-1 dB		0.009%		
ANALO	G INPUT					
	Center voltage			0.5 V _{CC}	V	
	Input impedance		10	20	kΩ	
Microph	none Bias					
ALC = C	DFF, microphone boost = 0 dB, PG	A = 0 dB, speaker and headphone = po	wered down, analog	mixing = disabled		
	Bias voltage			0.75 V _{CC}	V	
	Bias source current			2	mA	
	Output noise			6.5	μV	
Filter C	haracteristics					
INTERP	OLATION FILTER FOR DAC					
	Pass band			0.454 f _S		
	Stop band		0.546 f _S			
	Pass-band ripple			±0.04	dB	
	Stop-band attenuation		-50		dB	
	Group delay			19/f _s	S	
	De-emphasis error			±0.1	dB	
ANALO	G FILTER FOR DAC					
	Frequency response	f = 20 kHz		±0.2	dB	
DECIMA	ATION FILTER FOR ADC					
	Pass band			0.408 f _S		
	Stop band		0.591 f _S			
	Pass-band ripple			±0.02	dB	
	Stop-band attenuation	f < 3.268 f _S	-60		dB	
	Group delay			17/f _S	S	
HIGH-P	ASS FILTER FOR ADC		·	<u> </u>		
		-3 dB, $f_c = 4$ Hz		3.74		
		$-0.5 \text{ dB}, f_c = 4 \text{ Hz}$		10.66		
	F	$-0.1 \text{ dB, } f_c = 4 \text{ Hz}$		24.2		
	Frequency response	-3 dB, $f_c = 240$ Hz		235.68	Hz	
		-0.5 dB, $f_c = 240$ Hz		609.95		
		-0.1 dB, f _c = 240 Hz		2601.2	1	



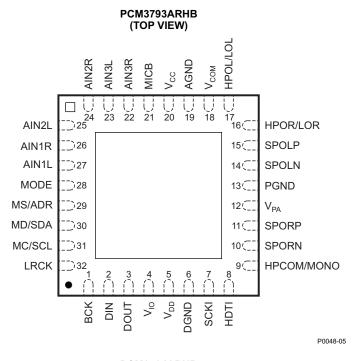
ELECTRICAL CHARACTERISTICS (continued)

All specifications at $T_A = 25^{\circ}C$, $V_{DD} = V_{IO} = V_{CC} = V_{PA} = 3.3 \text{ V}$, $f_S = 48 \text{ kHz}$, system clock = 256 f_S , and 16-bit data (unless otherwise noted).

	DADAMETED	TEST CONDITIONS	PCM3793ARI	HB, PCM3794	IARHB	LINUT
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Power	Supply and Supply Current		·			
V _{IO}			1.71	3.3	3.6	
V_{DD}	Voltage range		1.71	3.3	3.6	VDC
V_{CC}			2.4	3.3	3.6	VDC
V_{PA}			2.4	3.3	3.6	
	Cumply ourrent	BPZ input, all active, no load		24.3	35	mA
	Supply current	All inputs are held static		1	10	μΑ
	Davies dissination	BPZ input		80.2	115.5	mW
	Power dissipation	All inputs are held static		3.3	33	μW
Temp	erature Condition					
	Operation temperature		-40		85	°C
θ_{JA}	Thermal resistance			30		°C/W



PIN ASSIGNMENTS



PCM3794ARHB (TOP VIEW)

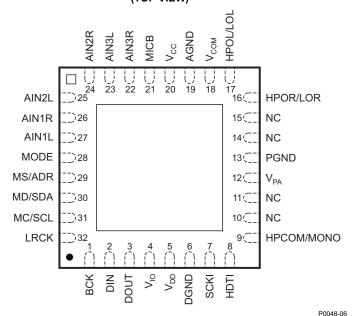


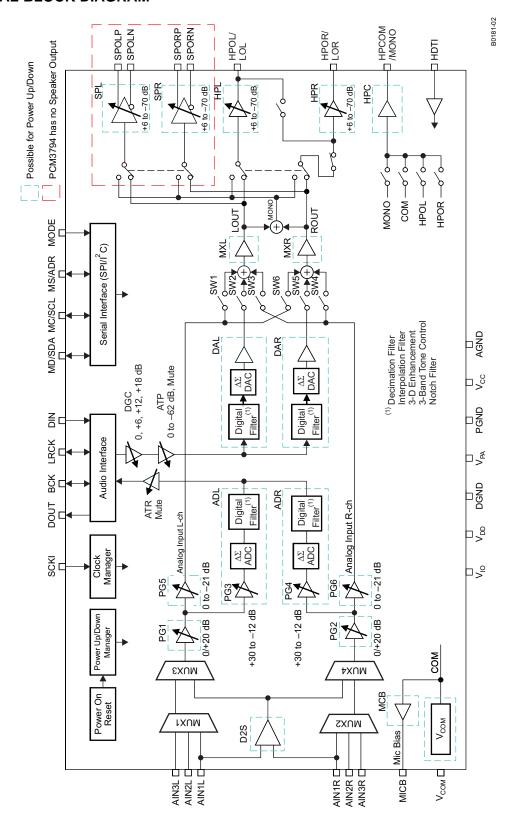


Table 1. TERMINAL FUNCTIONS

	TERMINAL			DECODIDETON
NAME	PCM3793ARHB	PCM3794ARHB	1/0	DESCRIPTION
AGND	19	19	_	Ground for analog
AIN1L	27	27	ı	Analog input 1 for L-channel
AIN1R	26	26	I	Analog input 1 for R-channel
AIN2L	25	25	I	Analog input 2 for L-channel
AIN2R	24	24	ı	Analog input 2 for R-channel
AIN3L	23	23	I	Analog input 3 for L-channel
AIN3R	22	22	I	Analog input 3 for R-channel
BCK	1	1	I/O	Serial bit clock
DGND	6	6	_	Digital ground
DIN	2	2	I	Serial audio data input
DOUT	3	3	0	Serial audio data output
HDTI	8	8	ı	Headphone plug insertion detection
HPCOM/MONO	9	9	0	Headphone common/mono line output
HPOL/LOL	17	17	0	Headphone/lineout for R-channel
HPOR/LOR	16	16	0	Headphone/lineout for L-channel
LRCK	32	32	I/O	Left and right channel clock
MC/SCL	31	31	I	Mode control clock for three-wire/two-wire interface
MD/SDA	30	30	I/O	Mode control data for three-wire/two-wire interface
MICB	21	21	0	Microphone bias source output
MODE	28	28	ı	Two- or three-wire interface selection (LOW: SPI, HIGH: I ² C)
MS/ADR	29	29	ı	Mode control select for three-wire/two-wire interface
PGND	13	13	_	Ground for speaker power amplifier
SCKI	7	7	ı	System clock
SPOLN	14	_	0	Speaker output L-channel for negative (PCM3793A)
SPOLP	15	_	0	Speaker output L-channel for positive (PCM3793A)
SPORN	10	_	0	Speaker output R-channel for negative (PCM3793A)
SPORP	11	_	0	Speaker output R-channel for positive (PCM3793A)
V _{CC}	20	20	_	Analog power supply
V _{COM}	18	18	_	Analog common voltage
V _{DD}	5	5	_	Power supply for digital core
V _{IO}	4	4	_	Power supply for digital I/O
V_{PA}	12	12		Power supply for power amplifier



FUNCTIONAL BLOCK DIAGRAM





TYPICAL PERFORMANCE CURVES

All specifications at $T_A = 25^{\circ}C$, $V_{DD} = V_{IO} = V_{CC} = V_{PA} = 3.3 \text{ V}$, $f_S = 8 \text{ to } 48 \text{ kHz}$, system clock = 256 f_S , and 16-bit data, unless otherwise noted.

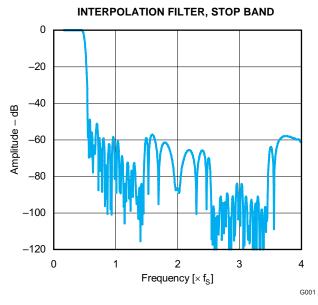


Figure 1.

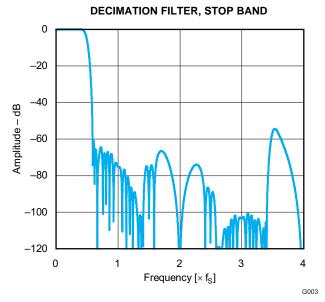


Figure 3.

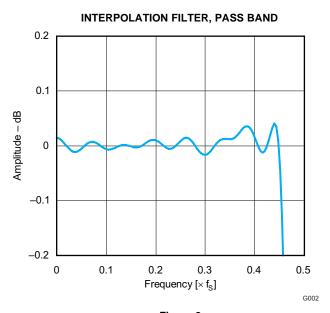


Figure 2.

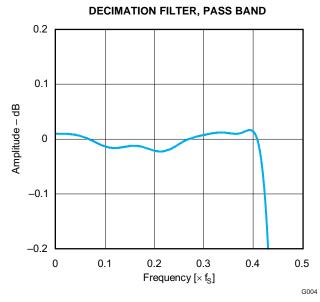
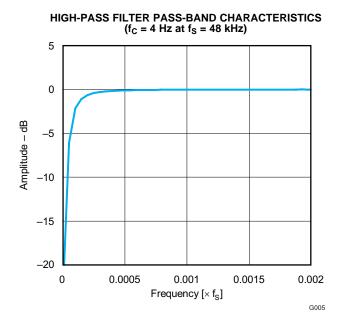


Figure 4.



All specifications at T_A = 25°C, V_{DD} = V_{IO} = V_{CC} = V_{PA} = 3.3 V, f_S = 8 to 48 kHz, system clock = 256 f_S , and 16-bit data, unless otherwise noted.



HIGH-PASS FILTER PASS-BAND CHARACTERISTICS (f_C = 120 Hz at f_S = 48 kHz)

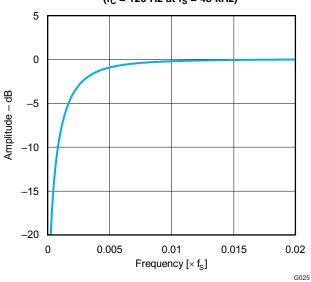


Figure 5.

Figure 6.

HIGH-PASS FILTER PASS-BAND CHARACTERISTICS (f $_{\rm C}$ = 240 Hz at f $_{\rm S}$ = 48 kHz)

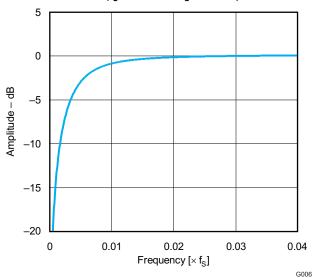


Figure 7.



All specifications at $T_A = 25^{\circ}C$, $V_{DD} = V_{IO} = V_{CC} = V_{PA} = 3.3 \text{ V}$, $f_S = 44.1 \text{ kHz}$, system clock = 256 f_S , and 16-bit data, unless otherwise noted.

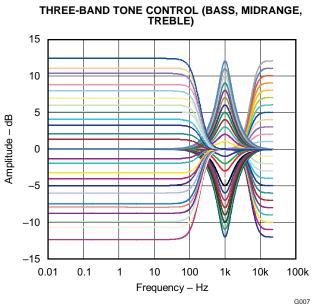


Figure 8.

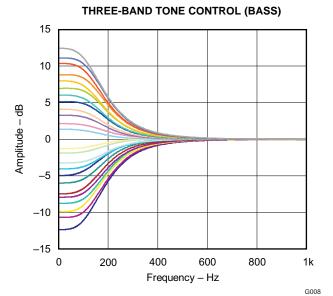


Figure 9.

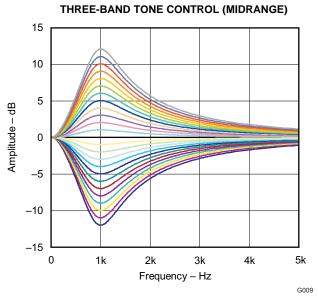


Figure 10.

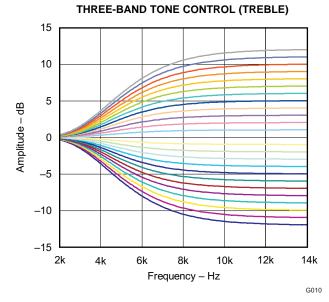


Figure 11.



All specifications at $T_A = 25^{\circ}C$, $V_{DD} = V_{IO} = V_{CC} = V_{PA} = 3.3 \text{ V}$, $f_S = 48 \text{ kHz}$, system clock = 256 f_S , and 16-bit data, unless otherwise noted.

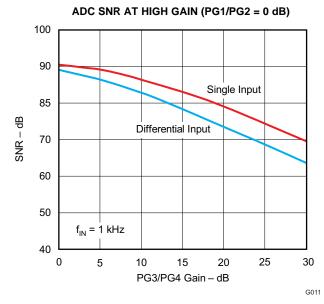


Figure 12.

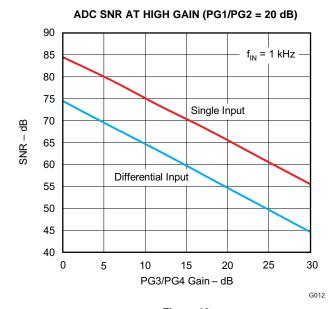


Figure 13.

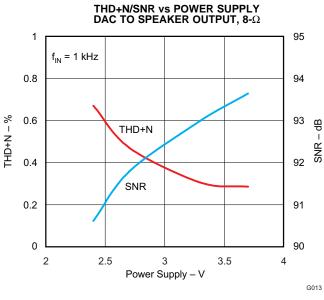


Figure 14.

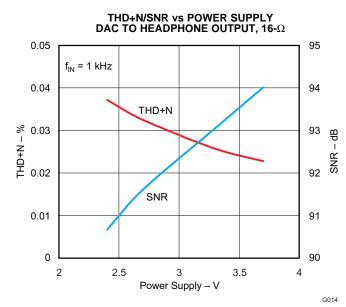
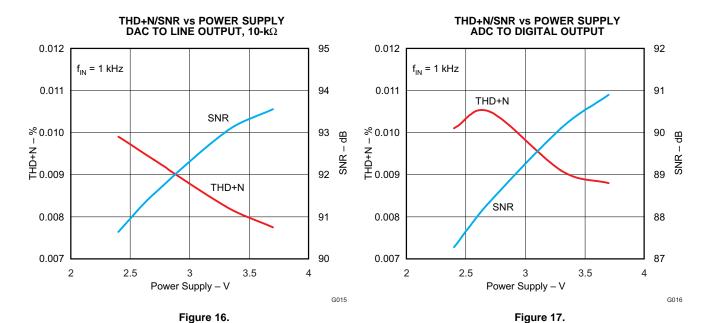


Figure 15.



All specifications at $T_A = 25$ °C, $V_{DD} = V_{IO} = V_{CC} = V_{PA} = 3.3$ V, $f_S = 48$ kHz, system clock = 256 f_S , and 16-bit data, unless otherwise noted.





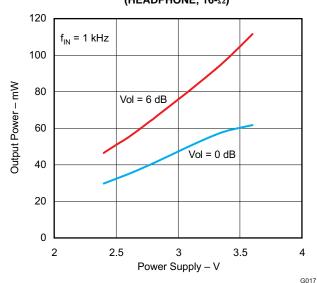


Figure 18.



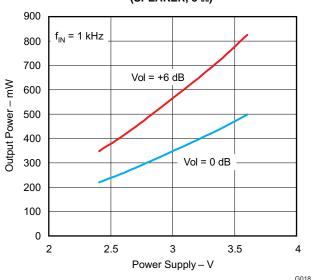


Figure 19.

THD+N vs OUTPUT POWER (HEADPHONE, 16- Ω , VOLUME = 0 dB)



TYPICAL PERFORMANCE CURVES (continued)

All specifications at $T_A = 25^{\circ}C$, $V_{DD} = V_{IO} = V_{CC} = V_{PA} = 3.3 \text{ V}$, $f_S = 48 \text{ kHz}$, system clock = 256 f_S , and 16-bit data, unless otherwise noted.

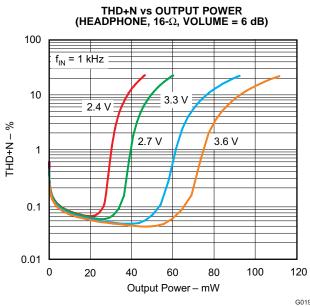
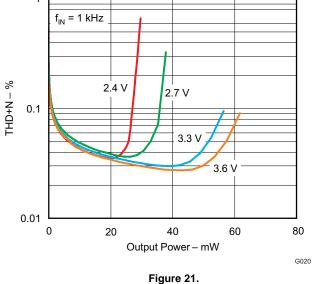


Figure 20.





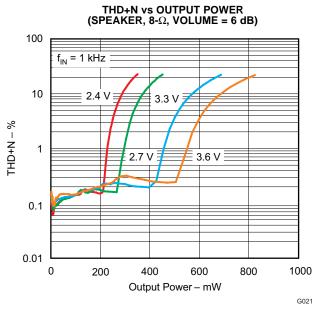


Figure 22.

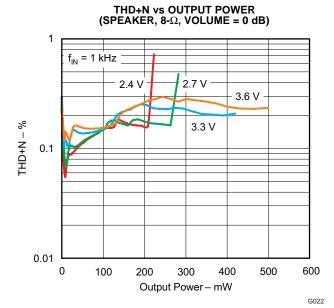


Figure 23.



All specifications at $T_A = 25$ °C, $V_{DD} = V_{IO} = V_{CC} = V_{PA} = 3.3$ V, $f_S = 48$ kHz, system clock = 256 f_S , and 16-bit data, unless otherwise noted.

OUTPUT SPECTRUM (DAC TO HEADPHONE OUTPUT, 16- $\!\Omega$)

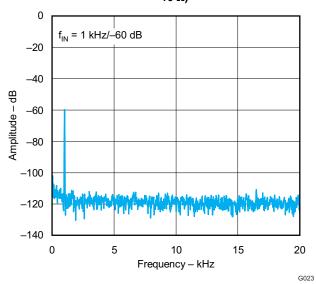


Figure 24.

OUTPUT SPECTRUM (DAC TO SPEAKER OUTPUT, 8- Ω)

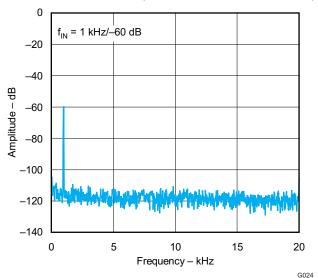


Figure 25.



PCM3793A/94A DESCRIPTION

Analog Input

The AIN1L, AIN1R, AIN2L, AIN2R, AIN3L, and AIN3R pins can be used as microphone or line inputs with selectable 0- or 20-dB boost and 1-Vrms input. All of these analog inputs have high input impedance (20 $k\Omega$), which is not changed by gain settings. One pair of inputs is selected by register 87 (AIL[1:0], AIR[1:0]). AIN1L and AIN1R can be used as a monaural differential input.

Gain Settings for Analog Input

The gain of the analog signals can be adjusted from 30 dB to -12 dB in 1-dB steps following the 0- or 20-dB boost amplifier. The gain level can be set for each channel by registers 79 and 80 (ALV[5:0], ARV[5:0]).

A/D Converter

The ADC includes a multilevel delta-sigma modulator, aliasing filter, decimation filter, high-pass filter, and notch filter and can accept a 1-Vrms full-scale voltage input. The decimation filter has a digital soft mute controlled by register 81 (RMUL, RMUR). The high-pass filter can be disabled by register 81 (HPF[1:0]), and the notch filter can be disabled by registers 96 to 104 if it is not necessary to cancel a dc offset or compensate for wind noise.

D/A Converter

The DAC includes a multilevel delta-sigma modulator and an interpolation filter. These can be used to obtain high PSRR, low jitter sensitivity, and low out-of-band noise quickly and easily. The interpolation filter includes digital attenuator, digital soft mute, three-band tone control (bass, midrange and treble), and 3-D sound controlled by registers 92 to 95. The de-emphasis filter (32, 44.1 and 48 kHz) is controlled by registers 68 to 70 (ATL[5:0], ATR[5:0], PMUL, PMUR, DEM[1:0]). Oversampling rate control can reduce out-of-band noise when operating at low sampling rates by using register 70 (OVER).

Common Voltage

The V_{COM} pin is normally biased to 0.5 V_{CC} , and it provides the common voltage to internal circuitry. It is recommended that a 4.7- μ F capacitor be connected between this pin and AGND to provide clean voltage and avoid pop noise. The PCM3793A/94A may have a little pop noise on each analog output if a capacitor smaller than 4.7 μ F is used.

Line Output

The HPOL/LOL, HPOR/LOR, and HPCOM/MONO pins can drive a $10\text{-k}\Omega$ load and be configured by register 74 (HPS[1:0]) as a monaural single-ended, monaural differential, or stereo single-line output with 1-V_{rms} output. These outputs, except for the HPCOM/MONO pin, include an analog volume amplifier that can be set from 6 dB to -70 dB and mute in steps of 0.5-, 1-, 2- or 4-dB. Each output is controlled by registers 64 and 65 (HLV[5:0], HRV[5:0], HMUL, HMUR). No dc blocking capacitor is required when connecting an external speaker amplifier with monaural differential input. The center voltage is 0.5 V_{CC} with zero data input.

Headphone Output

The HPOL/LOL, HPOR/LOR, and HPCOM/MONO pins can be configured as a stereo, monaural, or monaural differential headphone output by register 74 (HPS[1:0]). These pins have more than 30 or 40 mWrms output power into a 32- or $16-\Omega$ load, either through a dc blocking capacitor or without a capacitor. These outputs, except for the HPCOM/MONO pin, include an analog volume amplifier that can be set from 6 dB to -70 dB in steps of 0.5, 1, 2, or 4 dB. Each is controlled by registers 64 and 65 (HLV[5:0], HRV[5:0], HMUL, HMUR). The center voltage is 0.5 V_{CC} with zero data input.

Headphone Plug Insertion Detection

The HDTI pin detects the insertion status of headphone plug and writes the status to register 77 (HPDS), which can be read by the I^2C interface. The polarity of the status indication can be inverted by register 75 (HPDP). The headphone and speaker amplifiers are disabled or enabled automatically by headphone plug insertion/extractrion if register 75, HPDE = 1. They follow the register settings if register 75, HPDE = 0. HPCOM/MONO is not affected by the status when register 74, CMS[0] = 1.



Speaker Output (Class-D, PCM3793A)

The SPOLP/SPOLN and SPORP/SPORN pins are stereo or mono speaker differential outputs (BTL) pairs with a maximum of 700 mWrms ($V_{PA} = 3.6$ V, volume = 6 dB) into an 8- Ω load. The digital speaker amplifier offers maximum battery life, minimum heat, and elimination of LC low-pass filtering. The speaker amplifier includes an analog volume control with 6 dB to -70 dB in steps of 0.5, 1, 2 or 4 dB steps for each output, which can be set by registers 66 (SLV[5:0] and 67 SRV[5:0]). Spectrum spreading technology and selectable switching frequency to reduce EMI noise are controlled by register 71 (DFQ[2:0], SPS[1:0] and SPSE). This digital amplifier has a thermal shutdown circuit that detects when the device temperature reaches approximately 150°C; then the speaker amplifier is shut down.

Analog Mixing and Bypass

Mixing amplifiers (MXL, MXR) mix inputs from the AIN pins. The analog inputs are selected by register 87 (AD2S, AIR[1:0],AIL[1:0]) and can bypass the ADC/DAC and connect the mixed signal to the headphone or speaker outputs by register 88 (MXR[2:0], MXL[2:0]). The gain of the analog inputs is controlled by register 89 (GMR[2:0], GML[2:0]). These functions are suitable for FM radio, headset, and other analog sources without an ADC.

Microphone Bias

The MICB pin is the microphone bias source for an external microphone. MICB can provide 2 mA (typical) of bias current.

Digital Gain Control

A portable application with small speakers may be require a high sound level when playing back audio data recorded at low level. Digital gain control (DGC) can be used to amplify the digital input data by 0, 6, 12 or 18 dB by setting register 70 (SPX[1:0]).

Automatic Level Control (ALC) for Recording

The sound for microphone recording should be expanded to a suitable level without saturation. The digitally controlled automatic level control (ALC) provides automatic expansion for small input signals and compression for large input signals while recording. The expansion level, compression level, attack time, and recovery time can be selected by register 83. The register 83 description explains the details of these settings.

3-D Sound

A 3-D sound effect is provided by mixing L-channel and R-channel data with a band-pass filter with two parameters, mixing ratio and band pass filter characteristic, that can be controlled by register 95 (3DP[3:0], 3FLO). The 3-D sound effect uses the DAC digital input or ADC digital output selected by register 95 (SDAS).

Three-Band Tone Control

Tone control has bass, midrange, and treble controls that can be adjusted from 12 dB to -12 dB in 1-dB steps by registers 92 to 94 (LGA[4:0], MGA[4:0] and HGA[4:0]). Register 92 (LPAE) attenuates the digital input signal automatically to prevent clipping of the output signal at settings above 0 dB for bass control. LPAE has no effect on midrange and treble controls.

High-Pass Filter and Two-Stage Programmable Notch Filter

The high-pass filter eliminates the dc offset of the ADC analog signal and can be set for a cutoff frequency of 4 Hz, 120 Hz, or 240 Hz at the 48-kHz sampling frequency by register 81 (HPF[1:0]). A register 95 (SDAS) selection applies the filter to either the DAC digital input or the ADC digital output.

Notch filters are provided to remove noise of a particular frequency, such as CCD noise, motor noise, or other mechanical noise in a particular application. The PCM3793A/94A has two notch filters for which the center frequency and frequency bandwidth can be programmed by registers 96 to 104. A register 95 (SDAS) selection applies the filter to either the DAC digital input or the ADC digital output.



Digital Monaural Mixing

The audio data can be converted from stereo digital data to mixed monaural digital data. The conversion occurs in the internal audio interface section and is controlled by register 96 (MXEN).

Zero-Cross Detection

Zero-cross detection minimizes audible zipper noise while changing analog volume and digital attenuation. This function applies to the digital input or digital output as defined by register 86 (ZCRS).

Short Protection

The short-circuit protection on each headphone output prevents damage to the device while an output is shorted to V_{PA} , an output is shorted to PGND, or any two outputs are shorted together. When the short circuit is detected on the outputs, the PCM3793A/94A powers down the shorted amplifier immediately. The short-protection status can be monitored by reading register 77 (STHC, STHL, SCHR) through the I^2C interface. Short-circuit protection operates in any enabled headphone amplifier.

Thermal Protection

The thermal protection on the speaker amplifier prevents damage to the device when the internal die temperature exceeds approximately 150°C. Once the die temperature exceeds the thermal set point, all analog outputs are powered down. This status can be reset by setting register 76 (RLSR, RLSL) and can be watched by reading register 77 (STSR, STSL) through the two-wire (I²C) interface. Thermal protection operates in any enabled speaker amplifier.

Pop-Noise Reduction Circuit

The pop-noise reduction circuit prevents audible noise when turning the power supply on/off and powering the device up/down in portable applications. It is recommended to establish the register settings in the sequence that is shown in Table 3 and Table 4. No particular external parts are required.

Power Up/Down for Each Module

Using register 72 (PMXL, PMXR), register 73 (PBIS, PDAR, PDAL, PHPC, PHPR, PHPL, PSPR, PSPL), register 82 (PAIR, PAIL, PADS, PMCB, PADR, PADL), and register 90 (PCOM), unused modules can be powered down to minimize power consumption (7 mW during playback only and 13 mW when recording only).

Digital Audio Interface

The PCM3793A/94A can receive I^2S , right-justified, left-justified, and DSP formats in both master and slave modes. These options can be selected in register 70 (PFM[1:0]), register 81 (RFM[1:0]) and register 84 (MSTR).

Digital Interface

All digital I/O pins can interface at various power supply voltages. V_{IO} pin can be connected to a 1.71-V to 3.6-V power supply.

Power Supply

The V_{CC} pin and the V_{PA} pin can be connected to 2.4 V to 3.6 V. The same voltage must be applied to both pins. The V_{DD} pin and the V_{IO} pin can be connected to 1.71 V to 3.6 V. A different voltage can be applied to each of these pins (for example, $V_{DD} = 1.8$ V, $V_{IO} = 3.3$ V).



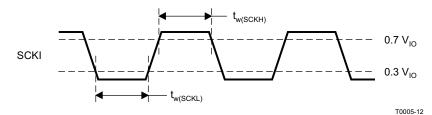
DESCRIPTION OF OPERATION

System Clock Input

The PCM3793A/94A can accept clocks of various frequencies without a PLL. They are used for clocking the digital filters and automatic level control and delta-sigma modulators and are classified as common-audio and application-specific clocks. Table 2 shows frequencies of the common-audio clock and application-specific clock. Figure 26 shows the timing requirements for system clock inputs. The sampling rate and frequency of the system clocks are determined by the settings of register 86 (MSR[2:0]) and register 85 (NPR[5:0]). Note that the sampling rate of the application-specific clock has a little sampling error. The details are shown in Table 12.

Table 2. System Clock Frequencies

CLOCK	FREQUENCIES			
Common-audio clock	11.2896, 12.288, 16.9344, 18.432 MHz			
Application-specific clock	12, 13, 13.5, 24, 26, 27, 19.2, 19.68, 38.4, 39.36 MHz			



PARAMETERS	SYMBOL	MIN	UNITS
System-clock pulse duration, high	t _{w(SCKH)}	7	ns
System-clock pulse duration, low	t _{w(SCKL)}	7	ns

Figure 26. System Clock Timing

Power-On Reset and System Reset

The power-on-reset circuit outputs a reset signal, typically at $V_{DD} = 1.2 \text{ V}$, and this circuit does not depend on the voltage of other power supplies (V_{CC} , V_{PA} , and V_{IO}). Internal circuits are cleared to default status, then signals are removed from all analog and digital outputs. The PCM3793A/94A does not require any power supply sequencing. Register data must be written after turning all power supplies on.

System reset is enabled by setting register 85 (SRST = 1). After the reset sequence, the register data is reset to SRST = 0 automatically. All circuits are cleared to their default status at once by the system reset. Note that the PCM3793A/94A has audible pop noise on the analog outputs when enabling SRST.

Power On/Off Sequence

To reduce audible pop noise, a sequence of register settings is required after turning all power supplies on when powering up, or before turning the power supplies off when powering down. If some modules are not required for a particular application or operation, they should be placed in the power-down state after performing the power-on sequence. The recommended power-on and power-off sequences are shown in Table 3 and Table 4, respectively.



Table 3. Recommended Power-On Sequence

STEP	REGISTER SETTINGS	NOTE
1	_	Turn on all power supplies ⁽¹⁾
2	4027h	Headphone amplifier L-ch volume (–6 dB) ⁽²⁾
3	4127h	Headphone amplifier R-ch volume (–6 dB) ⁽²⁾
4	4227h	Speaker amplifier L-ch volume (–6 dB) ⁽²⁾
5	4327h	Speaker amplifier R-ch volume (–6 dB) ⁽²⁾
6	4427h	Digital attenuator L-ch (-24 dB) ⁽²⁾
7	4527h	Digital attenuator R-ch (–24 dB) ⁽²⁾
8	4620h	DAC audio interface format (left-justified) ⁽³⁾
9	4BC0h	Headphone detection enable and inverting polarity. Short and thermal detection enable
10	5102h	ADC audio interface format (left-justified) ⁽³⁾
11	5A10h	V _{COM} ramp up/down time control. PG1, PG2 gain control (0 dB)
12	49E0h	DAC (DAL, DAR) and analog bias power up
13	5601h	Zero-cross detection enable
14	4803h	Analog mixer (MXL, MXR) power up
15	5811h	Analog mixer input (SW2, SW5) select
16	49FCh	Headphone amplifier (HPL, HPR, HPC) power up
17	4C03h	Speaker amplifier shut down release
18	4A01h	V _{COM} power up
19	523Fh	Analog front end (ADL, ADR, D2S, MCB, PG1, 2, 5, 6) power up
20	5711h	Analog input (MUX3, MUX4) select. Analog input (MUX1, MUX2) select
21	4F0Ch	Analog input L-ch (PG3) volume (0 dB) ⁽²⁾
22	500Ch	Analog input R-ch (PG4) volume (0 dB) ⁽²⁾
23	_	Any settings for other devices or wait time, 450 ms ⁽⁴⁾⁽⁵⁾
24	49FFh	Speaker amplifier (SPL, SPR) power up (5)

⁽¹⁾ V_{DD} should be turn on prior to or simultaneously with the other power supplies. It is recommended to set register data with the system clock input after turning all power supplies on.

Any level is acceptable for volume or attenuation. Level should be resumed by register data recorded when system power off. Audio interface format should be set to match the DSP or decoder being used. The PCM3793A requires time for V_{COM} to reach the common level from GND level. The delay depends on the capacitor value for V_{COM} and the setting of register 125 PTM[1:0], RES[4:0]. The default setting is 450 ms at $V_{COM} = 4.7 \, \mu s$. The PCM3794A does not require this setting because it has no speaker output.



Table 4. Recommended Power-Off Sequence

STEP	REGISTER SETTINGS	NOTE
1	447Fh	DAC L-ch digital soft-mute enable ⁽¹⁾
2	457Fh	DAC R-ch digital soft-mute enable ⁽¹⁾
3	5132h	ADC L-ch/R-ch digital soft-mute enable, ADC audio interface format (left-justified) (2)
4	5811h	Analog mixer input (SW2, SW5) select
5	49FCh	Headphone amplifier (HPL, HPR, HPC) power up (3)(4)
6	5200h	Analog front end (ADL, ADR, D2S, MCB, PG1, 2, 5, 6) power down
7	5A00h	PG1, PG2 gain control (0 dB)
8	4A00h	V _{COM} power down
9	-	Wait time (750 ms) (5)
10	49E0h	Headphone amplifier (HPL, HPR, HPC) power down, speaker amplifier (SPL, SPR) power down
11	4800h	Analog mixer (MXL, MXR) power down
12	4900h	DAC (DAL, DAR) and analog bias power down
13	_	Turn off all power supplies. (6)

- (1) Any level is acceptable for volume or attenuation.
- Audio interface format should be set to match the DSP or decoder in the application.
- The PCM3794A has no speaker amplifier.
- The headphone amplifier must be operating during the power-off sequence.
- PCM3793A requires time for V_{COM} to reach the ground level from the common level. The wait time allowed depends on the settings of register 125 PTM[1:0], RES[4:0]. The default setting is 750 ms for $V_{COM} = 4.7 \,\mu\text{F}$. Power supply sequencing is not required. It is recommended to turn off all power supplies after setting the registers with the system
- clock input.

Power-Supply Current

The current consumption of the PCM3793A/94A depends on power up/down status of each circuit module. In order to reduce the power consumption, disabling each module is recommended when it is not used in an application or operation. Table 5 shows the current consumption in some states.



Table 5. Power Consumption Table

OPERATION MODE	F	OWER SU	PPLY CURI	RENT [mA]		PD [mW]	PD [mW]
	V _{DD} (1.8 V)	V _{DD} (3.3 V)	V _{CC} (3.3 V)	V _{PA} (3.3 V)	V _{IO} (3.3 V)	TOTAL (V _{DD} = 1.8 V)	TOTAL (V _{DD} = 3.3 V)
All Power Down	0	0	0.007	0.002	0	0.03	0.03
All Active	2.5	5.1	7.5	11.6	0.1	67.7	80.2
PLAYBACK WITH DIGITAL INPUT							
Line output and headphone output	1.18	2.51	1.79	0.54	0.09	10.1	16.3
Headphone output with sound effect	1.81	3.84	1.79	0.54	0.09	11.2	20.7
Capless headphone output	1.18	2.51	1.8	0.75	0.09	10.8	17.0
Headphone output with line input (AIN2L/AIN2R)	1.18	2.52	2.09	0.54	0.09	11.1	17.3
Headphone output with mono microphone input (AIN1L, 20 dB)	1.18	2.52	2.5	0.54	0.09	12.5	18.6
Headphone output with mono differential microphone input (AIN1L/AIN1R, 20 dB)	1.18	2.52	2.8	0.54	0.09	13.4	19.6
Stereo speaker output	1.21	2.58	2.18	10.94	0.09	45.8	52.1
Mono speaker output	1.2	2.57	2.01	5.61	0.09	27.6	33.9
Speaker output with line input (AIN2L/AIN2R)	1.21	2.57	2.48	10.95	0.09	46.8	53.1
Speaker output with mono microphone input (AIN1L, 20 dB)	1.21	2.58	2.89	10.96	0.09	48.2	54.5
Speaker output with mono differential microphone input (AIN1L/AIN1R, 20 dB)	1.2	2.58	3.2	10.98	0.09	49.3	55.6
PLAYBACK WITHOUT DIGITAL INPUT			•				
Line input (AIN2L/AIN2R) to headphone output	0	0	0.76	0.53	0	4.3	4.3
Mono line input (AIN2L) to headphone output	0	0	0.61	0.53	0	3.8	3.8
Mono microphone Input (AIN1L, 20 dB) to headphone output	0	0	1.18	0.53	0	5.6	5.6
Mono differential microphone input (AIN1L/AIN1R, 20 dB) to headphone output	0	0	1.48	0.53	0	6.6	6.6
Mono microphone input (AIN1L, 20 dB) to speaker output	0	0	1.57	10.92	0	41.2	41.2
RECORDING							
Line input (AIN3L/AIN3R)	1.86	3.89	4.58	0.13	0.1	19.1	28.7
Microphone input (AIN1L/AIN1R, 20 dB)	1.86	3.91	5.14	0.13	0.1	21.1	30.6
Microphone input (AIN1L/AIN1R, 20 dB) with ALC	2.78	5.77	5.14	0.13	0.1	22.7	36.8
Mono microphone input (AIN1L, 20 dB)	1.4	2.93	3.6	0.13	0.1	15.2	22.3
Mono microphone input (AIN1L, 20 dB) with ALC	2.2	4.74	3.6	0.13	0.1	16.6	28.3
Mono differential microphone input (AIN1L/AIN1R, 20 dB)	1.4	2.94	3.96	0.13	0.1	16.3	23.5
Mono differential microphone input (AIN1L/AIN1R, 20 dB) with ALC	2.2	4.74	3.96	0.13	0.1	17.8	29.5
Conditions: 48 kHz/256 f _S , 16 bits, slave mode, zero data input, n	o load						

Audio Serial Interface

The audio serial interface for the PCM3793A/94A comprises LRCK, BCK, DIN, and DOUT. Sampling rate (f_S), left and right channel are present on LRCK. DIN receives the serial data for the DAC interpolation filter, and DOUT transmits the serial data from the ADC decimation filter. BCK clocks the transfer of serial audio data on DIN and DOUT in its high-to-low transition. BCK and LRCK should be synchronized with audio system clock. Ideally, it is recommended that they be derived from it.

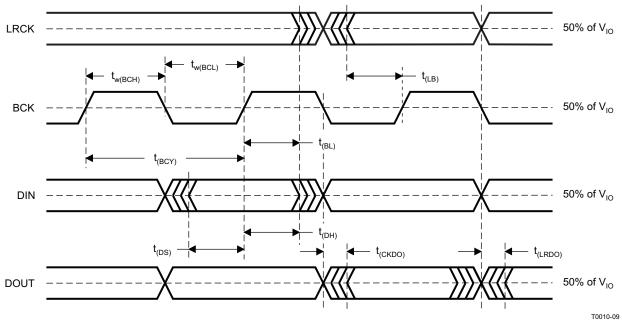
The PCM3793A/94A requires LRCK to be synchronized with the system clock. The PCM3793A/94A does not require a specific phase relationship between LRCK and the system clock.

The PCM3793A/94A has both master mode and slave mode interface formats, which can be selected by register 84 (MSTR). In master mode, the PCM3793A/94A generates LRCK and BCK from the system clock.

Audio Data Formats and Timing

The PCM3793A/94A supports I²S, right-justified, left-justified, and DSP formats. The data formats are shown in Figure 29 and are selected using registers 70 and 81 (RFM[1:0], PFM[1:0]). All formats require binary 2s-complement, MSB-first audio data. The default format is I²S. Figure 27 shows a detailed timing diagram.



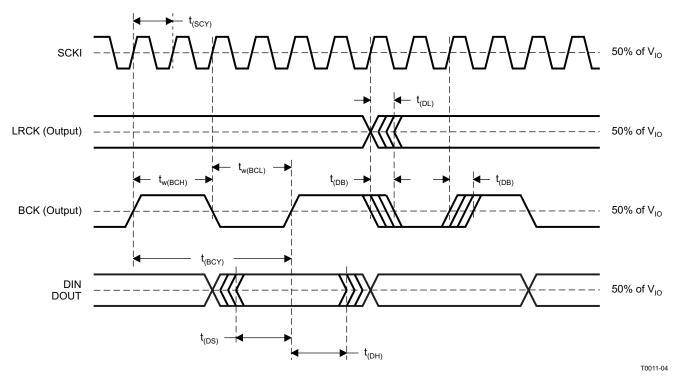


	PARAMETERS	MIN	MAX	UNITS
	BCK pulse cycle time (I ² S, left- and right-justified formats)	1/(64 f _S) ⁽¹⁾		
t _(BCY)	BCK pulse cycle time (DSP format)	1/(256 f _S) ⁽¹⁾		
t _{w(BCH)}	BCK high-level time	35		ns
t _{w(BCL)}	BCK low-level time	35		ns
t _(BL)	BCK rising edge to LRCK edge	10		ns
t _(LB)	LRCK edge to BCK rising edge	10		ns
t _(DS)	DIN set up time	10		ns
t _(DH)	DIN hold time	10		ns
t _(CKDO)	DOUT delay time from BCK falling edge		15	ns
t _(LRDO)	DOUT delay time from LRCK falling edge		15	ns
t _r	Rising time of all signals		10	ns
t _f	Falling time of all signals		10	ns

(1) f_S is the sampling frequency.

Figure 27. Audio Interface Timing (Slave Mode)

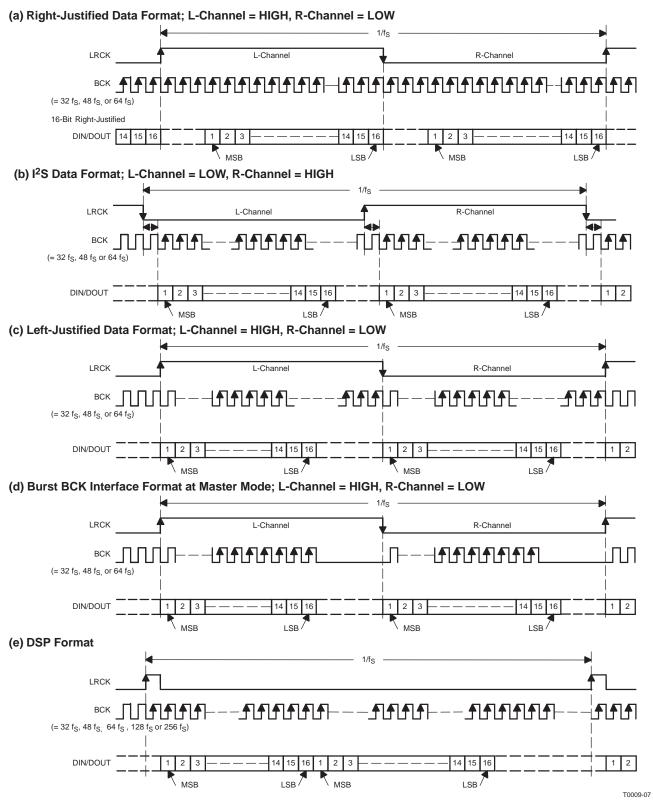




	PARAMETERS	MIN	MAX	UNIT
t _(SCY)	SCKI pulse cycle time	1/(256 f _S) ⁽¹⁾		
t _(DL)	LRCK edge from SCKI rising edge	0	40	ns
t _(DB)	BCK edge from SCKI rising edge	0	40	ns
t _(BCY)	BCK pulse cycle time	1/(64 f _S) ⁽¹⁾		
t _{w(BCH)}	BCK high level time	146		ns
t _{w(BCL)}	BCK low level time	146		ns
t _(DS)	DATA setup time	10		ns
t _(DH)	DATA hold time	10		ns

(1) f_S is up to 48 kHz. f_S is the sampling frequency. Figure 28. Audio Interface Timing (Master Mode)





NOTE: All audio interface formats support BCK = $64 f_S$ in master mode (register 69, MSTR = 1). When setting the multisampling rate, the f_S of BCK is set to half the rate of the DSP operation frequency.

Figure 29. Audio Data Input and Output Formats



THREE-WIRE INTERFACE (SPI, MODE (PIN 28) = LOW)

All write operations for the serial control port use 16-bit data words. Figure 30 shows the control data word format. The most-significant bit must be 0. There are seven bits, labeled IDX[6:0], that set the register address for the write operation. The least-significant eight bits, D[7:0], contain the data to be written to the register specified by IDX[6:0].

Figure 31 shows the functional timing diagram for writing to the serial control port. To write the data into the mode register, the data is clocked into an internal shift register on the rising edge of the MC clock. The serial data should change on the falling edge of the MC clock, and MS should be LOW during write mode. The rising edge of MS should be aligned with the falling edge of the last MC clock pulse in the 16-bit frame. MC can run continuously between transactions while MS is in the LOW state.

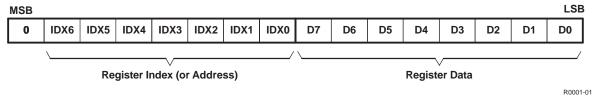
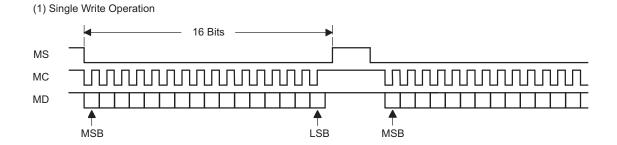


Figure 30. Control Data Word Format for MD



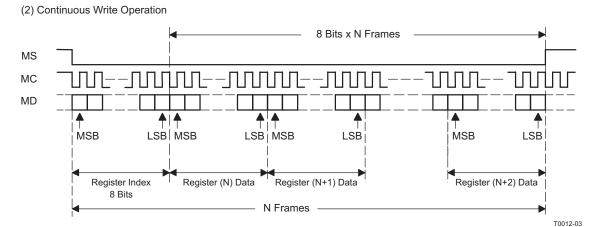
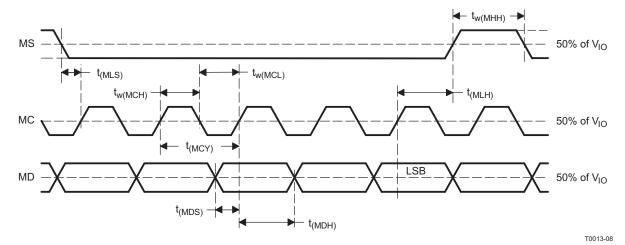


Figure 31. Register Write Operation



Three-Wire Interface (SPI) Timing Requirements

Figure 32 shows a detailed timing diagram for the serial control interface. These timing parameters are critical for proper control port operation.



	PARAMETERS	MIN	TYP	MAX	UNIT
t _(MCY)	MC pulse cycle time	500 ⁽¹⁾			ns
t _{w(MCL)}	MC low level time	50			ns
t _{w(MCH)}	MC high level time	50			ns
t _{w(MHH)}	MS high level time	(1)			ns
t _(MLS)	MS falling edge to MC rising edge	20			ns
t _(MLH)	MS hold time	20			ns
t _(MDH)	MD hold time	15			ns
t _(MDS)	MD setup time	20			ns

⁽¹⁾ $3/(128 f_S)$ s (min), where f_S is sampling rate.

Figure 32. SPI Interface Timing

TWO-WIRE INTERFACE [I²C, MODE (PIN 28) = HIGH]

The PCM3793A/94A supports the I^2C serial bus and the data transmission protocol for the I^2C standard as a slave device. This protocol is explained in I^2C specification 2.0.

In I²C mode, the control terminals are changed as follows.

TERMINAL NAME	PROPERTY	DESCRIPTION
MS/ADR	Input	I ² C address
MD/SDA	Input/output	I ² C data
MC/SCL	Input	I ² C clock

SLAVE ADDRESS

MSB							LSB
1	0	0	0	1	1	ADR	R/W

The PCM3793A/94A has its own 7-bit slave address. The first six bits (MSBs) of the slave address are factory preset to 100011. The last bit of the address byte is the device select bit, which can be user-defined by the ADR terminal. A maximum of two PCM3793A/94As can be connected on the same bus at one time. Each PCM3793A/94A responds when it receives its own slave address.



Packet Protocol

The master device must control packet protocol, which consists of start condition, slave address with read/write bit, data (if write) or acknowledgement (if read), and stop condition. The PCM3793A/94A supports only slave receiver and slave transmitter.

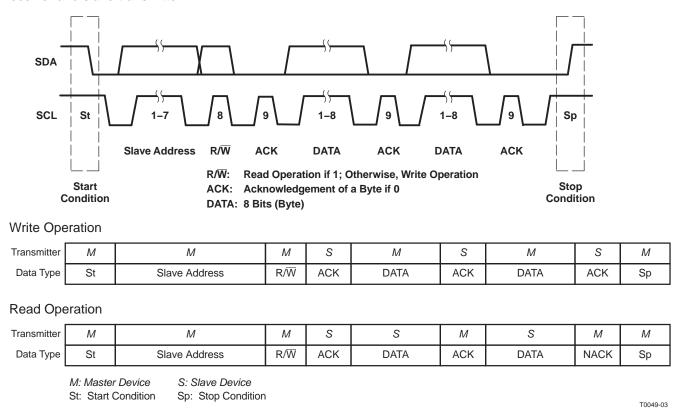


Figure 33. Basic I²C Framework

WRITE OPERATION

The master can write any PCM3793A/94A registers in a single access. The master sends a PCM3793A/94A slave address with a write bit, a register address, and data. When undefined registers are accessed, the PCM3793A/94A does not send any acknowledgement. Figure 34 shows a diagram of the write operation.

Transmitter	М	М	М	S	М	S	М	S	М
Data Type	St	Slave Address	W	ACK	Reg Address	ACK	Write Data	ACK	Sp

M: Master Device S: Slave Device

St: Start Condition W: Write ACK: Acknowledge Sp: Stop Condition

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Figure 34. Framework for Write Operation

READ OPERATION

The master can read PCM3793A/94A register. The value of the register address is stored in an indirect index register in advance. The master sends a PCM3793A/94A slave address with a read bit after storing the register address. Then the PCM3793A/94A transfers the data which the index register specifies. Figure 35 shows a diagram of the read operation.



Transmitter	М	М	М	S	М	S	М	М	М	S	S	М	М
Data Type	St	Slave Address	W	ACK	Reg Address	ACK	Sr	Slave Address	R	ACK	Read Data	NACK	Sp

M: Master Device S: Slave Device St: Start Condition

Sr: Repeated Start Condition ACK: Acknowledge Sp: Stop Condition NACK: Not Acknowledge

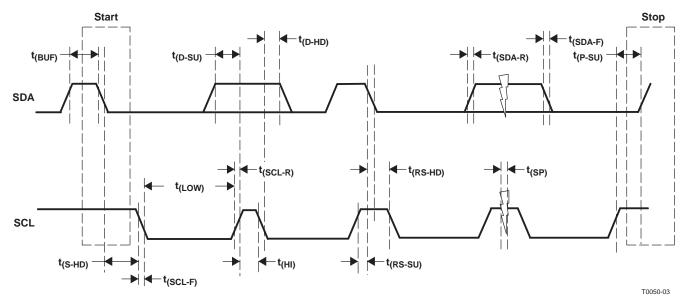
W: Write R: Read

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NOTE: The slave address after the repeated start condition must be the same as the previous slave address.

Figure 35. Read Operation

Timing Diagram



PARAMETERS CONDITIONS MIN MAX UNIT SCL clock frequency Standard 100 kHz f_{SCL} Bus free time between a STOP and START condition Standard 4.7 t_(BUF) μs Low period of the SCL clock Standard 4.7 μs $t_{(LOW)}$ High period of the SCL clock Standard 4 t_(HI) μs Setup time for START condition Standard 4.7 μ s t_(RS-SU) Hold time for START condition Standard 4 μs t_(S-HD) Data setup time Standard 250 ns t_(D-SU) Data hold time Standard 900 ns t_(D-HD) 20 + 0.1 C_B Rise time of SCL signal Standard 1000 ns t(SCL-R) Rise time of SCL signal after a repeated START condition and Standard $20 + 0.1 C_{B}$ 1000 ns t(SCL-R1) after an acknowledge bit Fall time of SCL signal Standard 20 + 0.1 C_B 1000 ns t_(SCL-F) Rise time of SDA signal Standard $20 + 0.1 C_{B}$ 1000 ns t(SDA-R) 1000 Fall time of SDA signal Standard 20 + 0.1 C_B ns t(SDA-F) Setup time for STOP condition Standard t_(P-SU) μs Capacitive load for SDA and SCL line C_B 400 pF Pulse duration of suppressed spike 25 ns t(SP)

Figure 36. I²C Interface Timing



USER-PROGRAMMABLE MODE CONTROLS

Register Map

The mode control register map is shown in Table 6. Each register includes an index (or address) indicated by the IDX[6:0] bits.

Table 6. Mode Control Register Map

REGISTER	IDX[6:0] (B14-B8)	DESCRIPTION	В7	В6	В5	В4	В3	B2	B1	В0
Register 64	40h	Volume for HPA (L-ch)	RSV	HMUL	HLV5	HLV4	HLV3	HLV2	HLV1	HLV0
Register 65	41h	Volume for HPA (R-ch)	RSV	HMUR	HRV5	HRV4	HRV3	HRV2	HRV1	HRV0
Register 66	42h	Volume for SPA (L-ch)	RSV	SMUL	SLV5	SLV4	SLV3	SLV2	SLV1	SLV0
Register 67	43h	Volume for SPA (R-ch)	RSV	SMUR	SRV5	SRV4	SRV3	SRV2	SRV1	SRV0
Register 68	44h	DAC digital attenuation and soft mute (L-ch)	RSV	PMUL	ATL5	ATL4	ATL3	ATL2	ATL1	ATL0
Register 69	45h	DAC digital attenuation and soft mute (R-ch)	RSV	PMUR	ATR5	ATR4	ATR3	ATR2	ATR1	ATR0
Register 70	46h	DAC over sampling, de-emphasis, audio interface	DEM1	DEM0	PFM1	PFM0	SPX1	SPX0	RSV	OVER
Register 71	47h	SPA (class-D) switching frequency	RSV	RSV	RSV	SPSE	SPS1	SPS0	DFQ1	DFQ0
Register 72	48h	Analog mixer power up/down	RSV	RSV	RSV	RSV	RSV	RSV	PMXR	PMXL
Register 73	49h	DAC, SPA and HPA power up/down	PBIS	PDAR	PDAL	PHPC	PHPR	PHPL	PSPR	PSPL
Register 74	4Ah	Analog output configuration select	RSV	CMS2	CMS1	CMS0	HPS1	HPS0	SPKS	PCOM
Register 75	4Bh	HPA insertion detection, short/thermal protection	HPDP	HPDE	RSV	SDHC	SDHR	SDHL	SDSR	SDSL
Register 76	4Ch	SPA shutdown release	RSV	RSV	RSV	RSV	RSV	RSV	RLSR	RLSL
Register 77	4Dh	Shut down status read back	HPDS	RSV	RSV	STHC	STHR	STHL	STSR	STSL
Register 79	4Fh	Volume for ADC input (L-ch)	RSV	RSV	ALV5	ALV4	ALV3	ALV2	ALV1	ALV0
Register 80	50h	Volume for ADC input (R-ch)	RSV	RSV	ARV5	ARV4	ARV3	ARV2	ARV1	ARV0
Register 81	51h	ADC high-pass filter, soft mute, audio interface	HPF1	HPF0	RMUL	RMUR	RSV	DSMC	RFM1	RFM0
Register 82	52h	ADC, MCB, PG1, 2, 5, 6, D2S power up/down	RSV	RSV	PAIR	PAIL	PADS	PMCB	PADR	PADL
Register 83	53h	Automatic level control for recording	RALC	RSV	RRTC	RATC	RCP1	RCP0	RLV1	RLV0
Register 84	54h	Master mode	RSV	RSV	RSV	RSV	RSV	MSTR	RSV	BIT0
Register 85	55h	System reset, sampling rate control	SRST	RSV	NPR5	NPR4	NPR3	NPR2	NPR1	NPR0
Register 86	56h	BCK configuration, sampling rate control, zero-cross	MBST	MSR2	MSR1	MSR0	ATOD	RSV	RSV	ZCRS
Register 87	57h	Analog input select (MUX1, 2, 3, 4)	AD2S	RSV	AIR1	AIR0	RSV	RSV	AIL1	AIL0
Register 88	58h	Analog mixing switch (SW1, 2, 3, 4, 5, 6)	RSV	MXR2	MXR1	MXR0	RSV	MXL2	MXL1	MXL0
Register 89	59h	Analog to analog path (PG5, 6) gain	RSV	GMR2	GMR1	GMR0	RSV	GML2	GML1	GML0
Register 90	5Ah	Microphone boost	RSV	RSV	RSV	RSV	RSV	RSV	G20R	G20L
Register 92	5Ch	Bass boost gain level	LPAE	RSV	RSV	LGA4	LGA3	LGA2	LGA1	LGA0
Register 93	5Dh	Middle boost gain level	RSV	RSV	RSV	MGA4	MGA3	MGA2	MGA1	MGA0
Register 94	5Eh	Treble boost gain level	RSV	RSV	RSV	HGA4	HGA3	HGA2	HGA1	HGA0
Register 95	5Fh	Sound effect source select, 3D sound	SDAS	3DEN	RSV	3FL0	3DP3	3DP2	3DP1	3DP0
Register 96	60h	2-stage notch filter, digital monaural mixing	NEN2	NEN1	NUP2	NUP1	RSV	RSV	RSV	MXEN
Register 97	61h	1st stage notch filter lower coefficient (a1)	F107	F106	F105	F104	F103	F102	F101	F100
Register 98	62h	1st stage notch filter upper coefficient (a1)	F115	F114	F113	F112	F111	F110	F109	F108
Register 99	63h	1st stage notch filter lower coefficient (a2)	F207	F206	F205	F204	F203	F202	F201	F200
Register 100	64h	1st stage notch filter upper coefficient (a2)	F215	F214	F213	F212	F211	F210	F209	F208
Register 101	65h	2nd stage notch filter lower coefficient (a1)	S107	S106	S105	S104	S103	S102	S101	S100
Register 102	66h	2nd stage notch filter upper coefficient (a1)	S115	S114	S113	S112	S111	S110	S109	S108
Register 103	67h	2nd stage notch filter lower coefficient (a2)	S207	S206	S205	S204	S203	S202	S201	S200
Register 104	68h	2nd stage notch filter upper coefficient (a2)	S215	S214	S213	S212	S211	S210	S209	S208
Register 125	7Dh	Power up/down time control	RSV	PTM1	PTM0	RES4	RES3	RES2	RES1	RES0
HPA: Headphone single-ended amp		A: Speaker amplifier DAC: D/A converter ADC: A/D converter	r MCB: N	licrophone	oias PGx	: Analog in	put buffer	D2S: Diffe	erential to	I.



Register Definitions

Registers 64 and 65

B15 B14 B13 B12 B11 B10 В9 B8 В7 В6 B5 B4 ВЗ B2 В1 В0 IDX4 RSV HMUL HLV5 HLV4 HLV3 HLV1 HLV0 0 IDX6 IDX5 IDX3 IDX2 IDX1 IDX0 HLV2 Register 64 HRV3 IDX5 IDX3 RSV **HMUR** HRV4 HRV0 Register 65 0 IDX6 IDX4 IDX2 IDX1 IDX0 HRV5 HRV2 HRV1

IDX[6:0]: 100 0000b (40h): Register 64 **IDX[6:0]:** 100 0001b (41h): Register 65

HMUL: Analog Mute Control for HPL (Line or Headphone L-Channel)
HMUR: Analog Mute Control for HPR (Line or Headphone R-Channel)

Default value: 1

HPOL/LOL and HPOR/LOR can be independently muted to zero level when HMUL and HMUR = 1. These settings take precedence over analog volume level settings.

HMUL, HMUR = 0 Mute disabled
HMUL, HMUR = 1 Mute enabled (default)

HLV[5:0]: Analog Volume for HPL (Headphone L-Channel) HRV[5:0]: Analog Volume for HPR (Headphone R-Channel)

Default value: 00 0000.

HPOL/LOL and HPOR/LOR can be independently controlled between 6 dB and -70 dB, with step size depending on the gain level as shown in Table 7. Outputs may have zipper noise while changing levels. This noise can be reduced by selecting zero-cross detection (register 86, ZCRS).

Table 7. Headphone Gain Level Setting

HLV[5:0 HRV[5:0		STEP	GAIN LEVEL SETTING	HLV[5:0], HRV[5:0]		STEP	GAIN LEVEL SETTING		HLV[5:0], HRV[5:0]		GAIN LEVEL SETTING
11 1111	3F		6 dB	10 1001	29		–5 dB	01 0011	13		–21 dB
11 1110	3E		5.5 dB	10 1000	28		−5.5 dB	01 0010	12	1 dB	–22 dB
11 1101	3D		5 dB	10 0111	27		−6 dB	01 0001	11	Tub	–23 dB
11 1100	3C		4.5 dB	10 0110	26		−6.5 dB	01 0000	10		–24 dB
11 1011	3B		4 dB	10 0101	25		−7 dB	00 1111	0F		–26 dB
11 1010	3A		3.5 dB	10 0100	24		–7.5 dB	00 1110	0E		–28 dB
11 1001	39		3 dB	10 0011	23	0.5 dB	–8 dB	00 1101	0D		-30 dB
11 1000	38		2.5 dB	10 0010	22		-8.5 dB	00 1100	0C		-32 dB
11 0111	37		2 dB	10 0001	21		−9 dB	00 1011	0B	2 dB	−34 dB
11 0110	36		1.5 dB	10 0000	20		−9.5 dB	00 1010	0A		-36 dB
11 0101	35	0.5 dB	1 dB	01 1111	1F		-10 dB	00 1001	09		-38 dB
11 0100	34	0.5 ub	0.5 dB	01 1110	1E		-10.5 dB	00 1000	08		-40 dB
11 0011	33		0 dB	01 1101	1D		–11 dB	00 0111	07		-42 dB
11 0010	32		−0.5 dB	01 1100	1C		−12 dB	00 0110	06		-46 dB
11 0001	31		−1 dB	01 1011	1B		−13 dB	00 0101	05		-50 dB
11 0000	30		-1.5 dB	01 1010	1A		-14 dB	00 0100	04		-54 dB
10 1111	2F		−2 dB	01 1001	19		–15 dB	00 0011	03	4 dB	–58 dB
10 1110	2E		-2.5 dB	01 1000	18	1 dB	-16 dB	00 0010	02		−62 dB
10 1101	2D		–3 dB	01 0111	17		–17 dB	00 0001	01		-66 dB
10 1100	2C		−3.5 dB	01 0110	16		–18 dB	00 0000	00		-70 dB
10 1011	2B		-4 dB	01 0101	15		–19 dB				
10 1010	2A		– 4.5 dB	01 0100	14		-20 dB				



Registers 66 and 67

	B15	B14	B13	B12	B11	B10	В9	В8	В7	В6	B5	В4	В3	B2	B1	В0
Register 66	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	RSV	SMUL	SLV5	SLV4	SLV3	SLV2	SLV1	SLV0
Register 67	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	RSV	SMUR	SRV5	SRV4	SRV3	SRV2	SRV1	SRV0

IDX[6:0]: 100 0010b (42h): Register 66 **IDX[6:0]:** 100 0011b (43h): Register 67

SMUL: Digital Soft Mute Control for SPL (Speaker Output, L-Channel) SMUR: Digital Soft Mute Control for SPR (Speaker Output R-Channel)

Default value: 1

SPOLP/SPOLN and SPORP/SPORN can be independently muted to the zero level when SMUL and SMUR = 1. These settings have precedence over analog volume level settings.

SMUL, SMUR = 0 Mute disabled
SMUL, SMUR = 1 Mute enabled (default)

SLV[5:0]: Gain Setting for SPL (Speaker Output L-Channel) SRV[5:0]: Gain Setting for SPR (Speaker Output R-Channel)

Default value: 00 0000.

SPOLP/SPOLN and SPORP/SPORN can be independently controlled between 6 dB and -70 dB, with step size depending on the gain level as shown in Table 8. Outputs may have zipper noise while changing levels. This noise can be reduced by selecting zero-cross detection (register 86, ZCRS).

Table 8. Speaker Gain Level Setting

SLV[5:0 SRV[5:0		STEP	GAIN LEVEL SETTING	SLV[5:0 SRV[5:0		STEP	GAIN LEVEL SETTING	SLV[5:0] SRV[5:0		STEP	GAIN LEVEL SETTING
11 1111	3F		6 dB	10 1001	29		–5 dB	01 0011	13		–21 dB
11 1110	3E		5.5 dB	10 1000	28		−5.5 dB	01 0010	12	1 dB	–22 dB
11 1101	3D		5 dB	10 0111	27		−6 dB	01 0001	11	TUB	-23 dB
11 1100	3C		4.5 dB	10 0110	26		−6.5 dB	01 0000	10		-24 dB
11 1011	3B		4 dB	10 0101	25		−7 dB	00 1111	0F		-26 dB
11 1010	3A		3.5 dB	10 0100	24		−7.5 dB	00 1110	0E		–28 dB
11 1001	39		3 dB	10 0011	23	0.5 dB	–8 dB	00 1101	0D		-30 dB
11 1000	38		2.5 dB	10 0010	22		−8.5 dB	00 1100	0C		-32 dB
11 0111	37		2 dB	10 0001	21		–9 dB	00 1011	0B	2 dB	-34 dB
11 0110	36		1.5 dB	10 0000	20		−9.5 dB	00 1010	0A		-36 dB
11 0101	35	0.5 dB	1 dB	01 1111	1F		-10 dB	00 1001	09		-38 dB
11 0100	34	0.5 UB	0.5 dB	01 1110	1E		-10.5 dB	00 1000	08		-40 dB
11 0011	33		0 dB	01 1101	1D		–11 dB	00 0111	07		-42 dB
11 0010	32		−0.5 dB	01 1100	1C		–12 dB	00 0110	06		-46 dB
11 0001	31		–1 dB	01 1011	1B		–13 dB	00 0101	05		-50 dB
11 0000	30		−1.5 dB	01 1010	1A		–14 dB	00 0100	04		-54 dB
10 1111	2F		–2 dB	01 1001	19		–15 dB	00 0011	03	4 dB	-58 dB
10 1110	2E		−2.5 dB	01 1000	18	1 dB	–16 dB	00 0010	02		-62 dB
10 1101	2D		−3 dB	01 0111	17		–17 dB	00 0001	01		-66 dB
10 1100	2C		−3.5 dB	01 0110	16		–18 dB	00 0000	00		-70 dB
10 1011	2B		−4 dB	01 0101	15		–19 dB				
10 1010	2A		– 4.5 dB	01 0100	14		-20 dB				



Registers 68 and 69

B15 B14 B13 B12 B11 B10 В9 В8 B7 В6 B5 B4 ВЗ B2 В1 B0 0 IDX6 IDX5 IDX4 IDX3 IDX2 IDX1 IDX0 RSV PMUL ATL5 ATL4 ATL3 ATL2 ATL1 ATL0 Register 68 0 IDX6 IDX5 IDX4 IDX3 RSV **PMUR** ATR5 ATR4 ATR3 ATR2 ATR1 ATR0 Register 69 IDX2 IDX1 IDX0

IDX[6:0]: 100 0100b (44h): Register 68 **IDX[6:0]:** 100 0101b (45h): Register 69

PMUL: Digital Soft Mute Control for DAL (DAC, L-Channel)
PMUR: Digital Soft Mute Control for DAR (DAC R-Channel)

Default value: 0

The digital inputs of the DAC can be independently muted by setting PMUL and PMUR = 1. The digital data is changed from the current attenuation level to mute level by a 1-dB step for every $8/f_S$ time period. When PMUL and PMUR are set to 0, the digital data is changed from the mute level to the current attenuation level by a 1-dB step for every $8/f_S$ time period. In the PCM3793A/94A, audible zipper noise can be reduced by selecting zero-cross detection (register 86, ZCRS).

PMUL, PMUR = 0 Mute disabled (default)
PMUL, PMUR = 1 Mute enabled

ATL[5:0]: Digital Attenuation Setting for DAL (L-Channel DAC) ATR[5:0]: Digital Attenuation Setting for DAR (R-Channel DAC)

Default value: 11 1111b

The digital inputs of the DAC can be independently attenuated. The attenuation of the digital input is changed by a 1-dB step for every 8/f_S time period. Audible zipper noise in the PCM3793A/94A can be reduced by selecting zero-cross detection (register 86, ZCRS).

Table 9. Digital Attenuation Setting

ATL[5:0] ATR[5:0		ATTENUATION LEVEL SETTING	ATL[5:0] ATR[5:0		ATTENUATION LEVEL SETTING	ATL[5:0] ATR[5:0		ATTENUATION LEVEL SETTING
11 1111	3F	0 dB (default)	10 1001	29	–22 dB	01 0011	13	-44 dB
11 1110	3E	−1 dB	10 1000	28	–23 dB	01 0010	12	–45 dB
11 1101	3D	−2 dB	10 0111	27	–24 dB	01 0001	11	-46 dB
11 1100	3C	−3 dB	10 0110	26	–25 dB	01 0000	10	–47 dB
11 1011	3B	–4 dB	10 0101	25	–26 dB	00 1111	0F	–48 dB
11 1010	3A	−5 dB	10 0100	24	−27 dB	00 1110	0E	−49 dB
11 1001	39	−6 dB	10 0011	23	–28 dB	00 1101	0D	-50 dB
11 1000	38	−7 dB	10 0010	22	–29 dB	00 1100	0C	−51 dB
11 0111	37	–8 dB	10 0001	21	-30 dB	00 1011	0B	−52 dB
11 0110	36	−9 dB	10 0000	20	−31 dB	00 1010	0A	−53 dB
11 0101	35	-10 dB	01 1111	1F	–32 dB	00 1001	09	–54 dB
11 0100	34	–11 dB	01 1110	1E	–33 dB	00 1000	08	−55 dB
11 0011	33	–12 dB	01 1101	1D	–34 dB	00 0111	07	−56 dB
11 0010	32	−13 dB	01 1100	1C	–35 dB	00 0110	06	–57 dB
11 0001	31	–14 dB	01 1011	1B	–36 dB	00 0101	05	–58 dB
11 0000	30	−15 dB	01 1010	1A	–37 dB	00 0100	04	–59 dB
10 1111	2F	–16 dB	01 1001	19	–38 dB	00 0011	03	-60 dB
10 1110	2E	–17 dB	01 1000	18	–39 dB	00 0010	02	−61 dB
10 1101	2D	–18 dB	01 0111	17	-40 dB	00 0001	01	−62 dB
10 1100	2C	−19 dB	01 0110	16	–41 dB	00 0000	00	Mute
10 1011	2B	–20 dB	01 0101	15	-42 dB			
10 1010	2A	–21 dB	01 0100	14	-43 dB			



Register 70

	B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
Register 70	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	DEM1	DEM0	PFM1	PFM0	SPX1	SPX0	RSV	OVER

IDX[6:0]: 100 0110b (46h): Register 70
DEM[1:0]: De-Emphasis Filter Selection

Default value: 00

A digital de-emphasis filter is in front of the interpolation filter. One of three de-emphasis filters can be selected corresponding to the sampling rate, 32 kHz, 44.1 kHz, or 48 kHz.

DEM[1:0]	De-Emphasis Filter Selection			
00	OFF (default)			
01	32 kHz			
10	44.1 kHz			
11	48 kHz			

PFM[1:0]: Audio Interface Selection for DAC (Digital Input)

Default value: 00

The audio interface for the DAC digital input has I²S, right-justified, left-justified, and DSP formats.

PFM[1:0]	Audio Interface Selection for DAC Digital Input			
00	I ² S format (default)			
01	Right-justified format			
10	Left-justified format			
11	DSP format			

SPX[1:0]: Digital Gain Control for DAC Input

Default value: 00

These bits are used to gain up the digital input data.

	<u> </u>	
SPX[1:0]	Digital Gain Control for DAC input	
00	0 dB (default)	
01	6 dB	
10	12 dB	
11	18 dB	

OVER: Oversampling Control for Delta-Sigma DAC

Default value: 0

This bit is used to control the oversampling rate of delta-sigma DAC. When the PCM3793A/94A operates at low sampling rates (less than 24 kHz) and the SCKI frequency is less than 12.5 MHz, OVER = 1 is recommended.

OVER = 0	128 f _S (default)
OVER = 1	192 f _S , 256 f _S , 384 f _S

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Register 71

B14 B13 B12 B11 B10 В9 В8 B7 В6 В5 B4 ВЗ B2 В1 В0 Register 71 IDX6 IDX5 IDX4 IDX3 IDX2 IDX1 IDX0 RSV RSV RSV SPSE SPS1 SPS0 DFQ1 DFQ0

IDX[6:0]: 100 0111b (47h): Register 71 SPSE: Enable of Spectrum Spreading

Default value: 0

The class-D speaker amplifier output can cause RF interference due to switching noise. The PCM3793A can reduce peak noise by the use of spectrum spreading technology when SPSE = 1.

SPSE = 0	Disable (default)
SPSE = 1	Enable

SPS[1:0]: Spectrum Spreading Efficiency

Default value: 00

The spectrum-spreading efficiency of can be selected from low, medium, and high.

SPS[1:0]	Spectrum Spreading Efficiency				
00	Low (default)				
01	Medium				
10	High				
11	Reserved				

DFQ[1:0]: Switching Frequency for Speaker Amplifier (Class-D)

Default value: 00

The switching frequency of the class-D speaker amplifier can be selected to avoid interference with other equipment.

DFQ[1:0]	Class D Amplifier Switching Frequency						
00	1.5 MHz (default)						
01	2.25 MHz						
10	2.65 MHz						
11	3 MHz						

Register 72

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	В3	B2	B1	В0
Register 72	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	RSV	RSV	RSV	RSV	RSV	RSV	PMXR	PMXL

IDX[6:0]: 100 1000b (48h) Register 72

PMXR: Power Up/Down for MXR (Mixer R-Channel)
PMXL: Power Up/Down for MXL (Mixer L-Channel)

Default value: 0

These bits are used to control power up/down for the analog mixer.

PMXL, $PMXR = 0$	Power down (default)
PMXL, PMXR = 1	Power up



B14 B13 B12 B11 B10 В9 В8 B7 В6 В5 B4 ВЗ B2 В1 B0 IDX6 IDX5 IDX3 IDX2 IDX1 IDX0 PBIS PDAR PDAL PHPC PHPR PHPL PSPR PSPL Register 73 IDX4

IDX[6:0]: 100 1001b (49h): Register 73 PBIS: Power Up/Down Control for Bias

Default value: 0

This bit is used to control power up/down for the analog bias circuit.

PBIS = 0 Power down (default)
PBIS = 1 Power up

PDAR: Power Up/Down Control for DAR (DAC and R-Channel Digital Filter)

PDAL: Power Up/Down Control for DAL (DAC and L-Channel Digital Filter)

Default value: 0

These bits are used to control power up/down for the DAC and interpolation filter.

PDAR, PDAL = 0 Power down (default)
PDAR, PDAL = 1 Power up

PHPC: Power Up/Down Control for HPC (Headphone COM/Monaural Output)

Default value: 0

This bit is used to control power up/down for the headphone COM or monaural line amplifier.

PHPC = 0 Power down (default)
PHPC = 1 Power up

PHPR: Power Up/Down Control for HPR (Line or R-Channel Headphone Output)
PHPL: Power Up/Down Control for HPL (Line or L-Channel Headphone Output)

Default value: 0

These bits are used to control power up/down for the headphone amplifier.

PHPR, PHPL = 0 Power down (default)
PHPR, PHPL = 1 Power up

PSPR: Power Up/Down Control for SPR (R-Channel Speaker Output, PCM3793A)

PSPL: Power Up/Down Control for SPL (L-Channel Speaker Output, PCM3793A)

Default value: 0

These bits are used to control power up/down for the PCM3793A speaker amplifier. These bits should be set to 0 for the PCM3794A, because it has no speaker outputs.

PSPR, PSPL = 0 Power down (default)
PSPR, PSPL = 1 Power up

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Register 74

B14 B13 B12 B11 B10 В9 В8 В7 В6 В5 B4 ВЗ B2 В1 В0 Register 74 IDX6 IDX5 IDX4 IDX3 IDX2 IDX1 IDX0 RSV CMS2 CMS1 CMS0 HPS1 HPS0 SPKS PCOM

IDX[6:0]: 100 1010b (4Ah): Register 74

CMS[2:0]: Output Selection for HPC (Headphone COM/Monaural Output)

Default value: 000

The HPCOM/MONO output can be selected from several input analog sources, including inverted HPOR output, inverted HPOL output, and monaural output.

CMS[2:0]	HPCOM/MONO Output Selection	
0 0 0	Common voltage (0.5 V _{CC}) output for capless mode (default)	
0 0 1	Monaural output	
0 1 0	Inverted HPOL output	
100	Inverted HPOR output	
Others	Reserved	

HPS[1:0]: Line or Headphone Output Configuration

Default value: 00

HPOL/LOL and HPOR/LOR can be configured selected as follows.

HPS[1:0]	Line or Headphone Output Configuration
0 0	Stereo output (default)
0 1	Single monaural output
1 0	Differential monaural output
1 1	Reserved

SPKS: Speaker Output Configuration

Default value: 00

SPOLP/SPOLN and SPORP/SPORN can be configured as follows.

SPKS = 0	Stereo output (default)
SPKS = 1	Monaural output

PCOM: Power Up/Down Control for V_{COM}

Default value: 0

This bit is used to control power up/down for V_{COM}.

PCOM = 0	Power down (default)
PCOM = 1	Power up



	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	В3	B2	B1	В0
Register 75	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	HPDP	HPDE	RSV	SDHC	SDHR	SDHL	SDSR	SDSL

IDX[6:0]: 1001011b (4Bh): Register 75

HPDP: Headphone Insertion Detection Polarity

HPDE: Enable for Headphone Insertion Detection

Default value: 0

Table 10. Headphone Insertion Detection

HPDE	HPDP	HDTI (PIN 8)	HP OUTPUT SP OUTPU		
1	0	0	Down	Uр	
1	0	1	Up	Down	
1	1	0	Up	Down	
1	1	1	Down	Up	
0	Х	Х	Headphone insertion detection disabled		

SDHC: Short Protection Disable for HPC (Headphone COM/Monaural Output)

SDHR: Short Protection Disable for HPR (R-Channel Headphone)

SDHL: Short Protection Disable for HPL (L-Channel Headphone)

Default value: 0

Short-circuit protection can be disabled if this function is not needed in an application.

SDHC, SDHR, SDHL = 0	Enabled (default)
SDHC, SDHR, SDHL = 1	Disabled

SDSR: Thermal Protection Disable for SPR (Speaker Amplifier R-Channel)

SDSL: Thermal Protection Disable for SPL (Speaker Amplifier L-Channel)

Default value: 0

The thermal protection circuit can be disabled if this function is not needed in an application.

SDSR, SDSL = 0	Enabled (default)
SDSR, SDSL = 1	Disabled

Register 76

B14 B10 В9 В8 В1 B0 IDX5 0 IDX6 IDX4 IDX3 IDX2 IDX1 IDX0 RSV RSV RSV RSV RSV RSV RLSR RLSL Register 76

IDX[6:0]: 100 1100b (4Ch): Register 76

RLSR: Reset Thermal Protection Circuit for SPR (R-Channel Speaker Amplifier)

RLSL: Reset Thermal Protection Circuit for SPL (L-Channel Speaker Amplifier)

Default value: 0

A thermal protection circuit puts the device in power-down status after it detects a temperature of approximately 150°C on the die. These bits must be set to 1 to restore power to the speaker amplifier.

RLSR, RLSL = 0	Operation (default)
RLSR, RLSL = 1	Reset (set to 0 automatically after being set to 1)

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Register 77

B14 B13 B12 B11 B10 В9 В8 В7 В6 B5 B4 ВЗ B2 В1 В0 Register 77 0 IDX6 IDX5 IDX4 IDX3 IDX2 IDX1 IDX0 HPDS RSV RSV STHC STHR STHL STSR STSL

IDX[6:0]: 100 1101b (4Dh): Register 77 HPDS: Headphone Detection Status

Default value: 0

The HPDS bit shows the status of insertion detection for the headphone. This is a read-only bit. The polarity depends on the register 75 (HPDP) setting.

HPDS = 0	HDTI input (when HPDP = 0) (default)
HPDS = 1	Inverted HDTI input (When HPDP = 1)

STHC: Short Protection Status for HPC (Headphone COM/Monaural Output)

STHR: Short Protection Status for HPR (R-Channel Headphone) STHL: Short Protection Status for HPL (L-Channel Headphone)

These bits can be used to read short protection status through the I²C interface.

STHC, STHR, STHL = 0	Detect short circuit
STHC, STHR, STHL = 1	Not detect short circuit

STSR: Thermal Protection Status for SPR (R-Channel Speaker)

STSL: Thermal Protection Status for SPL (L-Channel Speaker)

These bits can be used to read thermal protection status through the I²C interface.

STSR, STSL = 0	Detect thermal protection
STSR, STSL = 1	Not detect thermal protection



Registers 79 and 80

	B15	B14	B13	B12	B11	B10	B9	B8	В/	В6	B5	В4	В3	B2	В1	В0
Register 79	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	RSV	RSV	ALV5	ALV4	ALV3	ALV2	ALV1	ALV0
Register 80	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	RSV	RSV	ARV5	ARV4	ARV3	ARV2	ARV1	ARV0

IDX[6:0]: 100 1111b (4Fh): Register 79 **IDX[6:0]:** 101 0000b (50h): Register 80

ALV[5:0]: Gain Control for PG3 (R-Channel ADC Analog Input)
ARV[5:0]: Gain Control for PG4 (L-Channel ADC Analog Input)

Default value: 00

The gain of the PG3 and PG4 inputs to the ADC can be independently controlled from 30 dB to -12 dB in 1-dB steps. The ADC output may have zipper noise while changing the level. This noise can be reduced by using zero-cross detection (register 86, ZCRS).

Table 11. Gain Level Setting

ALV[5:0], ARV[5:0]		GAIN LEVEL SETTING	ALV[5:0], ARV[5:0]		GAIN LEVEL SETTING
10 1010	2A	30 dB	01 0100	14	8 dB
10 1001	29	29 dB	01 0011	13	7 dB
10 1000	28	28 dB	01 0010	12	6 dB
10 0111	27	27 dB	01 0001	11	5 dB
10 0110	26	26 dB	01 0000	10	4 dB
10 0101	25	25 dB	00 1111	0F	3 dB
10 0100	24	24 dB	00 1110	0E	2 dB
10 0011	23	23 dB	00 1101	0D	1 dB
10 0010	22	22 dB	00 1100	0C	0 dB
10 0001	21	21 dB	00 1011	0B	−1 dB
10 0000	20	20 dB	00 1010	0A	−2 dB
01 1111	1F	19 dB	00 1001	09	−3 dB
01 1110	1E	18 dB	00 1000	08	–4 dB
01 1101	1D	17 dB	00 0111	07	−5 dB
01 1100	1C	16 dB	00 0110	06	−6 dB
01 1011	1B	15 dB	00 0101	05	–7 dB
01 1010	1A	14 dB	00 0100	04	−8 dB
01 1001	19	13 dB	00 0011	03	−9 dB
01 1000	18	12 dB	00 0010	02	-10 dB
01 0111	17	11 dB	00 0001	01	–11 dB
01 0110	16	10 dB	00 0000	00	-12 dB (default)
01 0101	15	9 dB			



B14 B13 B12 B11 B10 В9 В8 B7 В6 B5 В4 ВЗ B2 В1 B0 IDX6 IDX5 IDX3 IDX2 IDX1 RMUL RMUR DSMC RFM1 RFM0 Register 81 IDX4 IDX0 HPF1 HPF0 RSV

IDX[6:0]: 101 0001b (51h): Register 81 HPF[1:0]: High-Pass Filter Selection

Default value: 00

The PCM3793A/94A has a digital high-pass filter to remove dc voltage at the input of the ADC. The cutoff frequency of the high-pass filter can be selected.

HPF [1:0]	High-Pass Filter Selection	
0 0	f _C = 4 Hz at 48 kHz (default)	
0 1	$f_C = 240 \text{ Hz at } 48 \text{ kHz}$	
1 0	$f_C = 120 \text{ Hz at } 48 \text{ kHz}$	
1 1	High-pass filter disabled	

RMUL: Digital Soft Mute Control for L-Channel ADC RMUR: Digital Soft Mute Control for R-Channel ADC

Default value: 1

The digital output of the ADC can be independently muted by setting RMUL and RMUR = 1. The digital data is changed from the current attenuation level to mute level by a 1-dB step for every $8/f_S$ time period. When PMUL and PMUR are set to 0, the digital data is changed from the mute level to the current attenuation level by a 1-dB step for every $8/f_S$ time period. In the PCM3793A/94A, audible zipper noise can be reduced by selecting zero-cross detection (register 86, ZCRS).

RMUL, RMUR = 0	Mute disabled
RMUL, RMUR = 1	Mute enabled (default)

DSMC: Waiting Time for ADC Mute Off at Power Up

Default value: 0

The ADC digital output has an optional delay after power up when DSMC = 0. It is recommended to set DSMC = 0.

DSMC = 0	10 ms at 48 kHz (default)
DSMC = 1	No delay

RFM[1:0]: Audio Interface Selection for ADC (Digital Output)

Default value: 00

The audio interface for the ADC digital input supports I²S, right-justified, left-justified, and DSP formats.

RFM [1:0]	Audio Interface Selection for ADC Digital Output
0 0	I ² S format (default)
0 1	Right-justified format
1 0	Left-justified format
1 1	DSP format



B15 B14 B13 B12 B11 B10 В9 B8 B7 В6 B5 B4 ВЗ B2 В1 B0 Register 82 IDX6 IDX5 IDX4 IDX3 IDX2 IDX1 IDX0 RSV RSV PAIR PAIL PADS PMCB PADR PADL

IDX[6:0]: 101 0010b (52h): Register 82

PAIR: Power Up/Down for PG2 and PG6 (Gain Amplifier for R-Channel Analog Input)

PAIL: Power Up/Down for PG1 and PG5 (Gain Amplifier for L-Channel Analog Input)

Default value: 0

These bits are used to control power up/down for PG2 and PG6 (gain amplifier for analog input).

PAIR, PAIL = 0 Power down (default)
PAIR, PAIL = 1 Power up

PADS: Power Up/Down for D2S (Differential Amplifier) of AIN1L and AIN1R

Default value: 0

This bit is used to control power up/down for D2S (differential-to-single amplifier).

PADS = 0 Power down (default)
PADS = 1 Power up

PMCB: Power Up/Down Control for Microphone Bias Source

Default value: 0

This bit is used to control power up/down for the microphone bias source.

PMCB = 0 Power down (default)
PMCB = 1 Power up

PADR: Power Up/Down Control for ADR (ADC and R-Channel Digital Filter)

PADL: Power Up/Down Control for ADL (ADC and L-Channel Digital Filter)

Default value: 0

These bits are used to control power up/down for the ADC and decimation filter.

PADR, PADL = 0 Power down (default)
PADR, PADL = 1 Power up



B12 B11 B10 В9 В8 В7 В6 B5 B4 ВЗ B2 В1 В0 Register 83 0 IDX6 IDX5 IDX4 IDX3 IDX2 IDX0 RALC RRTC RATC RCP1 RCP0 RLV1 RLV0

IDX[6:0]: 101 0011b (53h): Register 83

RALC: Automatic Level Control (ALC) Enable for Recording

Default value: 0

Automatic level control can be enabled with some parameters for microphone input or lower analog source level.

RALC = 0	Disable (default)
RALC = 1	Enable

RRTC: ALC Recovery Time Control for Recording

Default value: 0

This bit is used to select the recovery time for the ALC. The response is shown in Figure 37.

RRTC = 0	3.4 s (default)
RRTC = 1	13.6 s

RATC: ALC Attack Time Control for Recording

Default value: 0

This bit is used to select the attack time for the ALC. The response is shown in Figure 37.



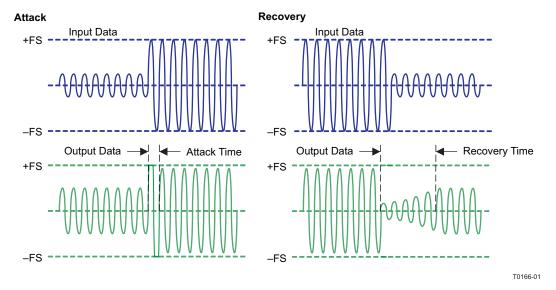


Figure 37. Attack and Recovery Time Response



RCP[1:0]: ALC Compression Level Control for Recording

Default value: 00

These bits are used to set the compression level for the ALC. The characteristic is shown in Figure 38.

RCP[1:0]	ALC Compression Level Control for Recording
0 0	-2 dB (default)
0 1	−6 dB
1 0	–12 dB
1 1	Reserved

RLV[1:0]: ALC Expansion Level Control for Recording

Default value: 00

These bits are used to set the expansion level for the ALC. The characteristic is shown in Figure 38.

RLV[1:0]	ALC Gain Level Control for Recording
0 0	0 dB (default)
0 1	6 dB
1 0	14 dB
1 1	24 dB

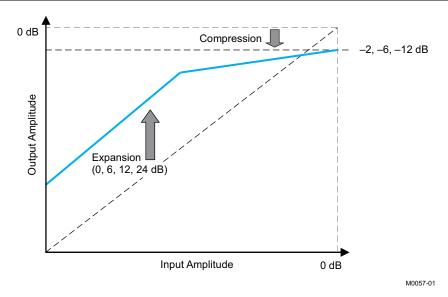


Figure 38. Compression and Expansion Characteristics

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Registers 84-86

B15 B14 B13 B12 B11 B10 В9 В8 В7 В6 B5 В4 ВЗ B2 В1 B0 IDX5 0 IDX6 IDX4 IDX3 IDX2 IDX1 IDX0 RSV MSTR RSV BIT0 Register 84 RSV RSV RSV RSV IDX5 IDX4 SRST NPR4 NPR2 NPR1 NPR0 0 IDX6 IDX3 IDX2 IDX1 IDX0 RSV NPR5 NPR3 Register 85 0 IDX6 IDX5 IDX4 IDX3 IDX2 MBST MSR0 RSV **ZCRS** Register 86 IDX1 IDX0 MSR2 MSR1 ATOD RSV

IDX[6:0]: 101 0100b (54h): Register 84 IDX[6:0]: 101 0101b (55h): Register 85 IDX[6:0]: 101 0110b (56h): Register 86

MSTR: Master or Slave Selection for Audio Interface

Default value: 0

This bit is used to select either master or slave mode for the audio interface. In master mode, the PCM3793A/94A generates LRCK and BCK from the system clock. In slave mode, it receives LRCK and BCK from another device.

MSTR = 0	Slave interface (default)
MSTR = 1	Master interface

BIT0: Bit Length Selection for Audio Interface

Default value: 1

This bit is used to select the data bit length for DAC input.

BIT0 = 0	Reserved
BIT0 = 1	16 bits (default)

SRST: System Reset

Default value: 0

This bit is used to enable system reset. All circuits are reset by setting SRST = 1. After completing the reset sequence, SRST is set to 0 automatically.

SRST = 0	Reset disabled (default)
SRST = 1	Reset enabled

NPR[5:0]: System Clock Rate Selection

Default value: 000000

MSR[2:0]: System Clock Dividing Rate Selection in Master Mode (Register 70)

Default value: 000

These bits are used to select the system clock rate and the dividing rate of the input system clock. See Table 12 for the details.



Table 12. System Clock Frequency for Common-Audio Clock

SYSTEM CLOCK	ADC SAMPLING RATE	DAC SAMPLING RATE	REGISTER S	SETTINGS ⁽¹⁾	BIT CLOCK
SCK (MHz)	ADC f _S (kHz)	DAC f _S (kHz)	MSR[2:0]	NPR[5:0]	BCK (f _S)
	24 (SC	CK/256)	010	00 0000	64
	16 (SC	CK/384)	011	00 0000	64
6.144	12 (SC	CK/512)	100	00 0000	64
0.144	8 (SC	K/768)	101	00 0000	64
	6 (SCk	(/1024)	110	00 0000	64
	4 (SCk	(/1536)	111	00 0000	64
	32 (SC	K/256)	010	00 0000	64
8.192	16 (SC	CK/512)	100	00 0000	64
	8 (SCk	(/1024)	110	00 0000	64
	48 (SC	CK/256)	010	00 0000	64
	32 (SC	CK/384)	011	00 0000	64
40.000	24 (SC	CK/512)	100	00 0000	64
12.288	16 (SC	CK/768)	101	00 0000	64
	12 (SCI	110	00 0000	64	
	8 (SCk	(/1536)	111	00 0000	64
	48 (SC	CK/384)	011	00 0000	64
18.432	24 (SC	CK/768)	101	00 0000	64
	12 (SCI	K/1536)	111	00 0000	64
	22.05 (S	CK/256)	010	00 0000	64
	14.7 (Sc	CK/384)	011	00 0000	64
5.0440	11.025 (\$	SCK/512)	100	00 0000	64
5.6448	7.35 (S	CK/768)	101	00 0000	64
	5.5125 (S	SCK/1024)	110	00 0000	64
	3.675 (Sc	CK/1536)	111	00 0000	64
	44.1 (Sc	CK/256)	010	00 0000	64
	29.4 (S	CK/384)	011	00 0000	64
44.0000	22.05 (S	SCK/512)	100	00 0000	64
11.2896	14.7 (S	CK/768)	101	00 0000	64
	11.025 (S	CK/1024)	110	00 0000	64
	7.35 (SC	CK/1536)	111	00 0000	64

⁽¹⁾ Other settings are reserved.



Table 13. System Clock Frequency for Application-Specific Clock

SYSTEM CLOCK	ADC SAMPLING RATE	DAC SAMPLING RATE	REGISTER	SETTINGS	BIT CLOCK
SCK (MHz)	ADC f _S (kHz) DAC f _S (kHz)		MSR[2:0]	NPR[5:0]	BCK (f _S)
	48.214 (SCK/280)	010	00 0010	70
	44.407 (SCK/304)	010	00 0001	76
	32.142 (SCK/420)	010	10 0010	70
40.5	24.107 (SCK/560)	100	00 0010	70
13.5	22.203 (SCK/608)	100	00 0001	76
	16.071 (SCK/840)	100	10 0010	70
	12.053 (S	SCK/1120)	110	00 0010	70
	8.035 (S	CK/1680)	110	10 0010	70
	48.214 (SCK/560)	010	01 0010	70
	44.407 (SCK/608)	010	01 0001	76
	32.142 (SCK/840)	010	11 0010	70
0.7	24.107 (S	SCK/1120)	100	01 0010	70
27	22.203 (S	SCK/1216)	100	01 0001	76
	16.071 (S	SCK/1680)	100	11 0010	70
	12.053 (S	SCK/2240)	110	01 0010	70
	8.035 (S	CK/3360)	110	11 0010	70
	48.387 (SCK/248)	010	00 0100	62
	44.117 (SCK/272)	010	00 0011	68
	32.258 (SCK/372)	010	10 0100	62
40	24.193 (SCK/496)	100	00 0100	62
12	22.058 (SCK/544)	100	00 0011	68
	16.129 (SCK/744)	100	10 0100	62
	12.096 (SCK/992)	110	00 0100	62
	8.064 (S	CK/1488)	110	10 0100	62
	48.387 (SCK/496)	010	01 0100	62
	44.117 (SCK/544)	010	01 0011	68
	32.258 (SCK/744)	010	11 0100	62
0.4	24.193 (\$	SCK/992)	100	01 0100	62
24	22.058 (S	SCK/1088)	100	01 0011	68
	16.129 (S	SCK/1488)	100	11 0100	62
	12.096 (S	SCK/1984)	110	01 0100	62
	8.064 (S	CK/2976)	110	11 0100	62
	48.484 (\$	SCK/396)	011	00 0110	66
	44.444 (SCK/432)	011	00 0101	72
	32.323 (SCK/594)	011	10 0110	66
40.0	24.242 (SCK/792)	101	00 0110	66
19.2	22.222 (SCK/864)	101	00 0101	72
	16.161 (S	SCK/1188)	101	10 0110	66
	12.121 (S	SCK/1584)	111	00 0110	66
	,	CK/2376)	111	10 0110	66



Table 13. System Clock Frequency for Application-Specific Clock (continued)

SYSTEM CLOCK	ADC SAMPLING RATE	DAC SAMPLING RATE	REGISTER	SETTINGS	BIT CLOCK	
SCK (MHz)	ADC f _S (kHz)	DAC f _S (kHz)	MSR[2:0]	NPR[5:0]	BCK (f _S)	
	48.484 (SCK/792)	011	01 0110	66	
	44.444 (SCK/864)	011	01 0101	72	
	32.323 (\$	SCK/1188)	011	11 0110	66	
00.4	24.242 (\$	SCK/1584)	101	01 0110	66	
38.4	22.222 (\$	SCK/1728)	101	01 0101	72	
	16.161 (\$	SCK/2376)	101	11 0110	66	
	12.121 (\$	SCK/3168)	111	01 0110	66	
	8.080 (S	CK/4752)	111	11 0110	66	
	47.794 (SCK/272)	010	00 1000	68	
	43.918 (SCK/296)	010	00 0111	74	
	31.862 (SCK/408)	010	10 1000	68	
40	23.897 (SCK/544)	100	00 1000	68	
13	21.959 (SCK/592)	100	00 0111	74	
	15.931 (SCK/816)	100	10 1000	68	
	11.948 (\$	SCK/1088)	110	00 1000	68	
	7.965 (S	CK/1632)	110	10 1000	68	
	47.794 (010	01 1000	68		
	43.918 (SCK/592)	010	01 0111	74	
	31.862 (SCK/816)	010	11 1000	68	
00	23.897 (\$	SCK/1088)	100	01 1000	68	
26	21.959 (\$	SCK/1184)	100	01 0111	74	
	15.931 (\$	SCK/1632)	100	11 1000	68	
	11.948 (\$	SCK/2176)	110	01 1000	68	
	7.965 (S	CK/3264)	110	11 1000	68	
	48.235 (SCK/408)	011	00 1010	68	
	44.324 (SCK/444)	011	00 1001	74	
	32.156 (SCK/612)	011	10 1010	68	
10.69	24.117 (SCK/816)	101	00 1010	68	
19.68	22.162 (SCK/888)	101	00 1001	74	
	16.078 (\$	SCK/1224)	101	10 1010	68	
	12.058 (\$	SCK/1632)	111	00 1010	68	
	8.039 (S	CK/2448)	111	10 1010	68	
	48.235 (SCK/816)	011	01 1010	68	
	44.324 (SCK/888)	011	01 1001	74	
	32.156 (\$	011	11 1010	68		
30.36	24.117 (\$	SCK/1632)	101	01 1010	68	
39.36	22.162 (\$	SCK/1776)	101	01 1001	74	
	16.078 (\$	SCK/2448)	101	11 1010	68	
	12.058 (\$	SCK/3264)	111	01 1010	68	
	8.039 (S	CK/4896)	111	11 1010	68	



MBST: BCK Output Configuration in Master Mode

Default value: 0

This bit is used to control the BCK output configuration in master mode. In master mode, this bit sets the BCK output configuration to normal mode or burst mode. In normal mode (MBST = 0), the BCK clock runs continuously. In burst mode (MBST = 1), the BCK clock runs intermittently, and the number of clock cycles per LRCK period is reduced to equal the number of bits of audio data being transmitted. Operating in burst mode reduces the power consumption of V_{IO} (I/O cell power supply). This is effective in master mode (register 69 MSTR = 1).

MBST = 0	Normal mode (default)
MBST = 1	Burst mode

ATOD: ADC Digital Output to DAC Digital Input (Loopback)

Default value: 0

The ADC digital output is internally connected to the DAC digital input by setting ATOD = 1. This setting can be used to debug ADC functions or to monitor a recording.

ATOD= 0	Disabled (default)
ATOD= 1	Enabled

ZCRS: Zero-Cross for Digital Attenuation/Mute and Analog Gain Setting

Default value: 0

This bit is used to enablethe zero-cross detector, which reduces zipper noise while the digital soft mute, digital attenuation analog gain setting, or analog volume setting is being changed. If no zero-cross data is input for a $512/f_S$ period (10.6 ms at a 48-kHz sampling rate), then a time-out occurs and the PCM3793A/94A starts changing the attenuation, gain, or volume level. The zero-cross detector cannot be used with continuous-zero and dc data.

ZCRS = 0	Zero-cross disabled (default)
ZCRS = 1	Zero-cross enabled



	B15	B14	B13	B12	B11	B10	В9	B8	B7	B6	B5	B4	В3	B2	B1	B0
Register 87	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	AD2S	RSV	AIR1	AIR0	RSV	RSV	AIL1	AIL0

IDX[6:0]: 101 0111b (57h): Register 87

AD2S: Differential Amplifier Selector (MUX3 and MUX4)

Default value: 0

The PCM3793A/94A has stereo single-input amplifiers (PG1, PG2) and a monaural differential-input amplifier (D2S) which can output signals to the ADC. MUX3 and MUX4 can be selected as the monaural differential input by setting AD2S = 1.

AD2S = 0	Single-input amplifiers (default)
AD2S = 1	Differential-input amplifier

AIL[1:0]: AIN1L, AIN2L, and AIN3L Selector (MUX1)

Default value: 00

These bits are used to select one of the three analog inputs, AIN1L, AIN2L, or AIN3L.

AIL[1:0]	AIN L-channel Select	
0 0	Disconnect (default)	
0 1	AIN1L	
1 0	AIN2L	
11	AIN3L	

AIR[1:0]: AIN1R, AIN2R, and AIN3R Selector (MUX2)

Default value: 00

These bits are used to select one of the three stereo analog inputs, AIN1R, AIN2R, or AIN3R.

AIR[1:0]	AIN R-channel Select	
0 0	Disconnect (default)	
0 1	AIN1R	
1 0	AIN2R	
1 1	AIN3R	

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Register 88

B14 B13 B12 B11 B10 В9 В8 B7 В6 В5 В4 ВЗ B2 В1 B0 IDX6 IDX5 IDX4 IDX3 IDX2 RSV MXR0 RSV MXL1 MXL0 Register 88 IDX1 IDX0 MXR2 MXR1 MXL2

IDX[6:0]: 101 1000b (58h): Register 88

MXR2: Mixing SW6 to MXR (R-Channel Mixing Amplifier) From L-Channel Analog Input

Default value: 0

This bit is used to mix the analog source into MXR (R-ch mixing amplifier) from the L-ch analog input.

MXR2 = 0	Disable (default)	
MXR2 = 1	Enable	

MXR1: Mixing SW4 to MXR (R-Channel Mixing Amplifier) From R-Channel Analog Input

Default value: 0

This bit is used to mix the analog source into MXR (R-ch mixing amplifier) from the R-ch analog input.

MXR1 = 0	Disable (default)
MXR1 = 1	Enable

MXR0: Mixing SW5 to MXR (R-Channel Mixing Amplifier) From R-Channel DAC

Default value: 0

This bit is used to mix the analog source into MXR (R-ch mixing amplifier) from the R-ch DAC.

MXR0 = 0	Disable (default)
MXR0 = 1	Enable

MXL2: Mixing SW3 to MXL (L-Channel Mixing Amplifier) From R-Channel Analog Input

Default value: 0

This bit is used to mix the analog source into MXL (L-ch mixing amplifier) from the R-ch analog input.

MXL2 = 0	Disable (default)
MXL2 = 1	Enable

MXL1: Mixing SW1 to MXL (L-Channel Mixing Amplifier) From L-Channel Analog Input

Default value: 0

This bit is used to mix the analog source into MXL (L-ch mixing amplifier) from the L-ch analog input.

MXL1 = 0	Disable (default)
MXL1 = 1	Enable

MXL0: Mixing SW2 to MXL (L-Channel Mixing Amplifier) From L-Channel DAC

Default value: 0

This bit is used to mix the analog source into MXL (L-ch mixing amplifier) from the L-ch DAC.

MXL0 = 0	Disable (default)
MXL0 = 1	Enable



	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	В3	B2	B1	В0
Register 89	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	RSV	GMR2	GMR1	GMR0	RSV	GML2	GML1	GML0

IDX[6:0]: 101 1001b (59h): Register 89

GMR[2:0]: Gain Level Control for PG6 (Gain Amplifier for Analog Input or R-Channel Bypass)

GML[2:0]: Gain Level Control for PG5 (Gain Amplifier for Analog Input or L-Channel Bypass)

Default value: 111

These bits are used for setting the gain level of the analog source to the mixing amplifier. It is recommended to set the gain level to avoid saturation in the analog mixer.

GMR[2:0] GML[2:0]	Gain Level Control for PG6 Gain Level Control for PG5	
0 0 0	–21 dB	
0 0 1	–18 dB	
0 1 0	–15 dB	
0 1 1	–12 dB	
1 0 0	−9 dB	
1 0 1	−6 dB	
1 1 0	−3 dB	
1 1 1	0 dB (default)	

Register 90

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	В3	B2	B1	B0
Register 90	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	RSV	RSV	RSV	RSV	RSV	RSV	G20R	G20L

IDX[6:0]: 1011010b (5Ah): Register 90

G20R: 20-dB Boost for PG2 (Gain Amplifier for AIN1R, AIN2R, and AIN3R)

Default value: 0

This bit is used to boost the microphone signal when the analog input is small.

G20R = 0	0 dB (default)
G20R = 1	20-dB boost

G20L: 20-dB Boost for PG1 (Gain Amplifier for AIN1L, AIN2L, and AIN3L)

Default value: 0

This bit is used to boost the microphone signal when the analog input is small.

G20L = 0	0 dB (default)
G20L = 1	20-dB boost

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Register 92

B14 B13 B12 B11 B10 В9 В8 B7 В6 B5 B4 ВЗ B2 В1 B0 Register 92 0 IDX6 IDX5 IDX4 IDX3 IDX2 IDX1 IDX0 LPAE RSV RSV LGA4 LGA3 LGA2 LGA1 LGA0

IDX[6:0]: 101 1100b (5Ch): Register 92

LPAE: Gain Adjustment for Bass Boost Gain Control

Default value: 0

A gain setting for bass boost may cause digital data may saturation, depending on the input data level. Where this could occur, LPAE can be used to set the same attenuation level as the bass boost gain level for the digital input data.

LPAE = 0	Disable (default)
LPAE = 1	Enable

LGA[4:0]: Bass Boost Gain Control

Default value: 0 0000

These bits are used to set the bass boost gain level for the digital data. The detailed characteristics are shown in the *Typical Performance Curves*.

LGA[4:0]	TONE CONTROL GAIN (BASS)	LGA[4:0]	TONE CONTROL GAIN (BASS)
0 0000	0 dB (default)	0 1111	0 dB
0 0011	12 dB	1 0000	-1 dB
0 0100	11 dB	1 0001	−2 dB
0 0101	10 dB	1 0010	−3 dB
0 0110	9 dB	1 0011	-4 dB
0 0111	8 dB	1 0100	–5 dB
0 1000	7 dB	1 0101	−6 dB
0 1001	6 dB	1 0110	−7 dB
0 1010	5 dB	1 0111	-8 dB
0 1011	4 dB	1 1000	−9 dB
0 1100	3 dB	1 1001	-10 dB
0 1101	2 dB	1 1010	-11 dB
0 1110	1 dB	1 1011	–12 dB



	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	В3	B2	B1	В0
Register 93	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	RSV	RSV	RSV	MGA4	MGA3	MGA2	MGA1	MGA0

IDX[6:0]: 101 1101b (5Dh): Register 93 MGA[4:0]: Middle Boost Gain Control

Default value: 0 0000

These bits are used to set the midrange boost gain level for the digital data. The detailed characteristics are shown in the *Typical Performance Curves*.

MGA[4:0]	TONE CONTROL GAIN (MIDRANGE)	MGA[4:0]	TONE CONTROL GAIN (MIDRANGE)
0 0000	0 dB (default)	0 1111	0 dB
0 0011	12 dB	1 0000	−1 dB
0 0100	11 dB	1 0001	−2 dB
0 0101	10 dB	1 0010	−3 dB
0 0110	9 dB	1 0011	-4 dB
0 0111	8 dB	1 0100	–5 dB
0 1000	7 dB	1 0101	−6 dB
0 1001	6 dB	1 0110	−7 dB
0 1010	5 dB	1 0111	–8 dB
0 1011	4 dB	1 1000	−9 dB
0 1100	3 dB	1 1001	-10 dB
0 1101	2 dB	1 1010	–11 dB
0 1110	1 dB	1 1011	–12 dB

Register 94

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	В3	B2	B1	В0
Register 94	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	RSV	RSV	RSV	HGA4	HGA3	HGA2	HGA1	HGA0

IDX[6:0]: 101 1110b (5Eh): Register 94

HGA[4:0]: Treble Boost Gain Control (f_C = 5 kHz)

Default value: 0 0000

These bits are used to set the treble boost gain level for the digital data. The detailed characteristics are shown in the *Typical Performance Curves*.

HGA[4:0]	TONE CONTROL GAIN (TREBLE)	HGA[4:0]	TONE CONTROL GAIN (TREBLE)
0 0000	0 dB (default)	0 1111	0 dB
0 0011	12 dB	1 0000	–1 dB
0 0100	11 dB	1 0001	−2 dB
0 0101	10 dB	1 0010	−3 dB
0 0110	9 dB	1 0011	-4 dB
0 0111	8 dB	1 0100	–5 dB
0 1000	7 dB	1 0101	−6 dB
0 1001	6 dB	1 0110	–7 dB
0 1010	5 dB	1 0111	–8 dB
0 1011	4 dB	1 1000	–9 dB
0 1100	3 dB	1 1001	–10 dB
0 1101	2 dB	1 1010	–11 dB
0 1110	1 dB	1 1011	−12 dB



B14 B13 B12 B11 B10 В9 В8 В7 В6 В5 B4 ВЗ B2 В1 В0 Register 95 0 IDX6 IDX5 IDX4 IDX3 IDX2 IDX1 IDX0 SDAS 3DEN RSV 3FL0 3DP3 3DP2 3DP1 3DP0

IDX[6:0]: 101 1111b (5Fh): Register 95

SDAS: Source Select for Sound Effect (Tone Control, 3-D Sound, Notch Filter, Mono Mix)

Default value: 0

The PCM3793A/94A includes sound effect circuits (tone control, 3-D sound, notch filter, mono mix) which can be used to filter either the digital input to the DAC or the digital output from the ADC. This bit selects the signal source of the sound effect circuit.

SDAS = 0	DAC digital input (default)
SDAS = 1	ADC digital output

3DEN: 3-D Sound Effect Enable

Default value: 0

This bit is used for enabling the 3-D sound effect filter. This filter has two independently controlled parameters.

3DEN = 0	Disable (default)
3DEN = 1	Enable

3FL0: Filter Selection for 3-D Sound

Default value: 0

This bit is used for selecting from two types of filter, narrow and wide. These filters have a different 3-D performance effect.

3FL0 = 0	Narrow (default)
3FL0 = 1	Wide

3DP[3:0]: Efficiency for 3-D Sound Effects

Default value: 0000

These bits are used for adjusting the 3-D sound efficiency. Higher percentages have greater efficiency.

3DP[3:0]	3D Sound Effect Efficiency	
0000	0% (default)	
0 0 0 1	10%	
0010	20%	
0 0 1 1	30%	
0 1 0 0	40%	
0 1 0 1	50%	
0110	60%	
0 1 1 1	70%	
1000	80%	
1001	90%	
1010	100%	
1011	Reserved	
: 1111	: Reserved	



B14 B13 B12 B11 B10 В9 В8 В7 В6 В5 В4 ВЗ B2 В1 В0 0 IDX6 IDX5 IDX4 IDX3 IDX2 IDX1 IDX0 NEN2 NEN1 NUP2 NUP1 RSV RSV RSV MXEN Register 96

IDX[6:0]: 110 0000b (60h): Register 96 NEN2: Second-Stage Notch Filter Enable

Default value: 0

PCM3793A/94A has two notch filters with characteristics that can be set separately. This bit is used to enable the second stage.

NEN2 = 0	Disable (default)
NEN2 = 1	Enable

NEN1: First-Stage Notch Filter Enable

Default value: 0

PCM3793A/94A has two notch filters with characteristics that can be set separately. This bit is used to enable the first stage.

NEN1 = 0	Disable (default)
NEN1 = 1	Enable

NUP2: Second-Stage Notch Filter Coefficients Update

Default value: 0

This bit is used to update the coefficients for the second-stage notch filter. The coefficients set by registers 101, 102, 103, and 104 are updated when NUP2 = 1.

NUP2 = 0	No Update (default)
NUP2 = 1	Update (set to 0 automatically after set to 1)

NUP1: First-Stage Notch Filter Coefficients Update

Default value: 0

This bit is used to update the coefficients for the first-stage notch filter. The coefficients set by registers 97, 98, 99, and 100 are updated when NUP1 = 1.

NUP1 = 0	No Update (default)
NUP1 = 1	Update (set to 0 automatically after being set to 1)

MXEN: Digital Monaural Mixing

Default value: 0

This bit is used to enable or disable monaural mixing in the section that combines L-ch data and R-ch data.

MXEN = 0	Stereo (default)
MXEN = 1	Monaural Mixing

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Registers 97-100

Register 97 Register 98 Register 99 Register 100

B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	В3	B2	B1	B0
0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	F107	F106	F105	F104	F103	F102	F101	F100
0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	F115	F114	F113	F112	F111	F110	F109	F108
0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	F207	F206	F205	F204	F203	F202	F201	F200
0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	F215	F214	F213	F212	F211	F210	F209	F208

IDX[6:0]: 110 0001b (61h): Register 97 IDX[6:0]: 110 0010b (62h): Register 98 IDX[6:0]: 110 0011b (63h): Register 99 IDX[6:0]: 110 0100b (64h): Register 100

F[107:100]: Lower 8 Bits of Coefficient a₁ for First-Stage Notch Filter F[115:108]: Upper 8 Bits of Coefficient a₁ for First-Stage Notch Filter F[207:200]: Lower 8 Bits of Coefficient a₂ for First-Stage Notch Filter F[215:208]: Upper 8 Bits of Coefficient a₂ for First-Stage Notch Filter

Default value: 0000 0000

These bits are used to change the characteristics of the first-stage notch filter. See Figure 39 for details.



Registers 101-104

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	В3	B2	B1	В0
Register 101	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	S107	S106	S105	S104	S103	S102	S101	S100
Register 102	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	S115	S114	S113	S112	S111	S110	S109	S108
Register 103	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	S207	S206	S205	S204	S203	S202	S201	S200
Register 104	0	IDX6	IDX5	IDX4	IDX3	IDX2	IDX1	IDX0	S215	S214	S213	S212	S211	S210	S209	S208

IDX[6:0]: 110 0101b (65h): Register 101 IDX[6:0]: 110 0110b (66h): Register 102 IDX[6:0]: 110 0111b (67h): Register 103 IDX[6:0]: 110 1000b (68h): Register 104

S[107:100]: Lower 8 Bits of Coefficient a₁ for Second-Stage Notch Filter S[115:108]: Upper 8 Bits of Coefficient a₁ for Second-Stage Notch Filter S[207:200]: Lower 8 Bits of Coefficient a₂ for Second-Stage Notch Filter S[215:208]: Upper 8 Bits of Coefficient a₂ for Second-Stage Notch Filter

Default value: 0000 0000

These bits are used to change the characteristics of the second-stage notch filter. See Figure 39 for details.

The PCM3793A/94A provides two notch filters for the digital input to the DAC or the digital output from the ADC. The optional filter characteristics of each filter are programmable. The characteristics are given by calculating the coefficients for three parameters, sampling frequency, center frequency, and bandwidth, as shown in Figure 39. All coefficients must be written as 2s-complement binary data into registers 97, 98, 99, 100, 101, 102, 103, and 104.

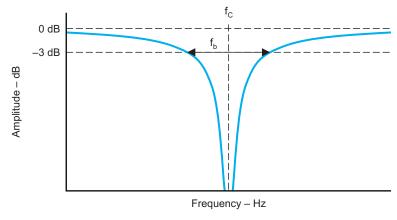
f_S: Sampling Frequency [Hz]

f_C: Center Frequency [Hz]

f_b: Band Width [Hz]

$$a_1 = -(1 + a_2) \cos \left(\frac{2\pi f_C}{f_S}\right)$$
 (Equation 1)

$$a_2 = \frac{1 - \tan\left(\frac{2\pi f_b/f_S}{2}\right)}{1 + \tan\left(\frac{2\pi f_b/f_S}{2}\right)}$$
 (Equation 2)



M0058-01

Figure 39. Parameter Settings for Notch Filter

The coefficients are calculated using Equation 1 and Equation 2 in Figure 39. An example follows:

 $f_S = 16 \text{ kHz}, f_C = 0.5 \text{ kHz}, f_b = 0.2 \text{ kHz}$

 $a_2 = 0.924390492 \rightarrow Decimal to Hex \rightarrow 3B29h$

 $a_1 = -1.887413868 \rightarrow Decimal to Hex \rightarrow 8735h$

 a_2 : F[215:208] = 3Bh, F[207:200] = 29h

a₁: F[115:108] = 87h, F[107:100] = 35h



В0 B14 B13 B12 B11 B10 В9 В8 В7 В6 B5 B4 ВЗ B2 В1 Register 125 0 IDX6 IDX5 IDX4 IDX3 IDX2 IDX1 IDX0 RSV PTM1 PTM0 RES4 RES3 RES2 RES1 RES0

IDX[6:0]: 111 1101b (7Dh): Register 125
PTM[1:0]: Power-Up/Down Time Control

Default value: 00

Table 14. Power Up/Down Time Control

V _{COM} CAPACITOR [μF]	RES[4:0]	PTM[1:0]	POWER-UP TIME [ms]	POWER-DOWN TIME [ms]	NOTE
	1 1110	00	450	750	
10	1 1100	11	900	1500	
10	1 1000	Do not set.	-	-	
	1 0000	Do not set.	-	-	
	1 1110	01	250	400	
4.7	1 1100	00	450	750	Default
4.7	1 1000	11	900	1500	
	1 0000	Do not set.	-	-	
	1 1110	10	100	300	
2.2	1 1100	01	250	400	
2.2	1 1000	00	450	750	
	1 0000	11	900	1500	
	1 1110	Do not set.	-	-	
1	1 1100	10	100	300	
	1 1000	01	250	400	
	1 0000	00	450	750	

RES[4:0]: Resistor Value Control

Default value: 1 1100

These bits are used to optimize audible pop noise and ramp-up time for the headphone output when powering the device on/off.

Table 15. Resistor Value Control

RES [4:0]	V _{COM} RESISTOR VALUE
1 0000	60 kΩ
1 1000	24 kΩ
1 1100	12 kΩ
1 1110	6 kΩ
Others	Reserved



CONNECTION DIAGRAMS

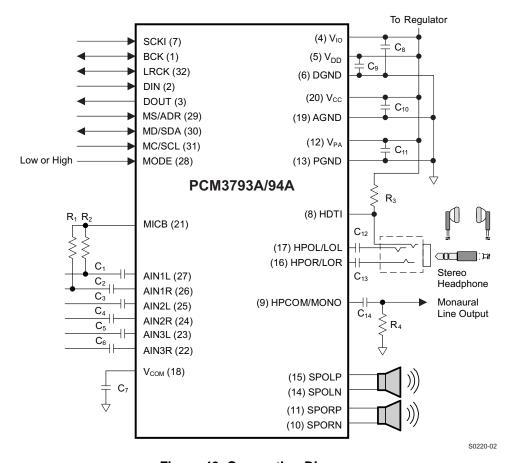
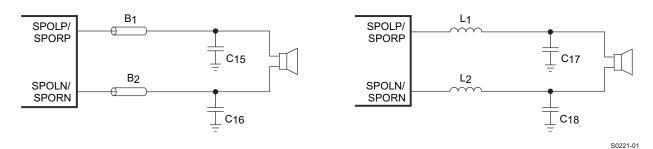


Figure 40. Connection Diagram

Table 16. Recommended External Parts

C ₁ –C ₆	1 μF	C ₁₂ , C ₁₃	10 μF–220 μF
C ₇	4.7 μF	C ₁₄	1 μF–10 μF
C ₈	0.1 μF	R ₁ , R ₂	2.2 kΩ
C ₉ , C ₁₀	1 μF–4.7 μF	R ₃	33 kΩ
C11	4.7 uF-10 uF	R ₄	10 kΩ



NOTE: C_{15}, C_{16} = 1 nF; C_{17}, C_{18} = 1 μ F; B_1, B_2 : NEC/Tokin N2012ZPS121; L_1, L_2 = 22 μ H to 33 μ H

Figure 41. Filter Consideration for Speaker Output



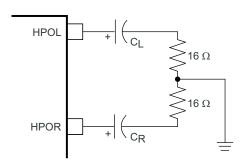
S0222-01

Conventional Mode

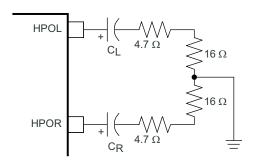
HDTI HP Jack HP Jack HPOR HPOR HPOR HPCOM HPCOM

Capless Mode

Figure 42. Connection for Headphone Output and Insertion Detection



$C_L, C_R - \mu F$	f _C – Hz				
10	995				
47	212				
100	100				
220	45				



C _L , C _R – μ F	f _C - Hz				
10	770				
47	163				
100	77				
220	35				

S0223-01

Figure 43. High-Pass Filter for Headphone Output

PACKAGE OPTION ADDENDUM



17-May-2014

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
PCM3793ARHBR	ACTIVE	VQFN	RHB	32	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	3793A	Samples
PCM3793ARHBRG4	ACTIVE	VQFN	RHB	32		TBD	Call TI	Call TI	-40 to 85		Samples
PCM3793ARHBT	ACTIVE	VQFN	RHB	32	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	3793A	Samples
PCM3793ARHBTG4	ACTIVE	VQFN	RHB	32		TBD	Call TI	Call TI	-40 to 85		Samples
PCM3794ARHBR	ACTIVE	VQFN	RHB	32	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	3794A	Samples
PCM3794ARHBRG4	ACTIVE	VQFN	RHB	32	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	3794A	Samples
PCM3794ARHBT	ACTIVE	VQFN	RHB	32	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	3794A	Samples
PCM3794ARHBTG4	ACTIVE	VQFN	RHB	32	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	3794A	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

PACKAGE OPTION ADDENDUM



17-May-2014

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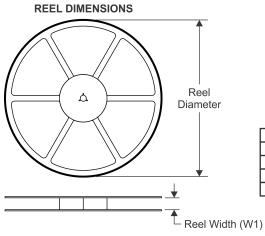
⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

PACKAGE MATERIALS INFORMATION

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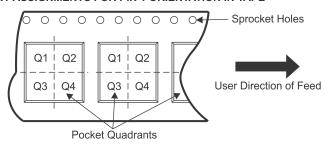
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



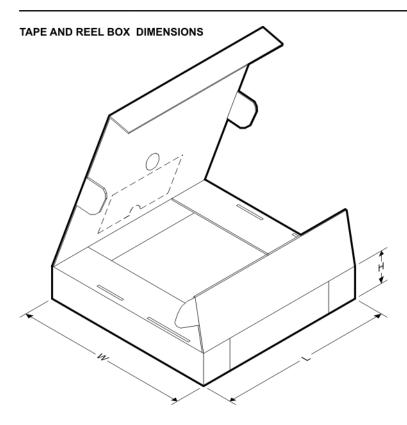
*All dimensions are nominal

All differsions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
PCM3793ARHBR	VQFN	RHB	32	3000	330.0	12.4	5.3	5.3	1.5	8.0	12.0	Q2
PCM3793ARHBT	VQFN	RHB	32	250	180.0	12.4	5.3	5.3	1.5	8.0	12.0	Q2
PCM3794ARHBR	VQFN	RHB	32	3000	330.0	12.4	5.3	5.3	1.5	8.0	12.0	Q2
PCM3794ARHBT	VQFN	RHB	32	250	180.0	12.4	5.3	5.3	1.5	8.0	12.0	Q2



PACKAGE MATERIALS INFORMATION

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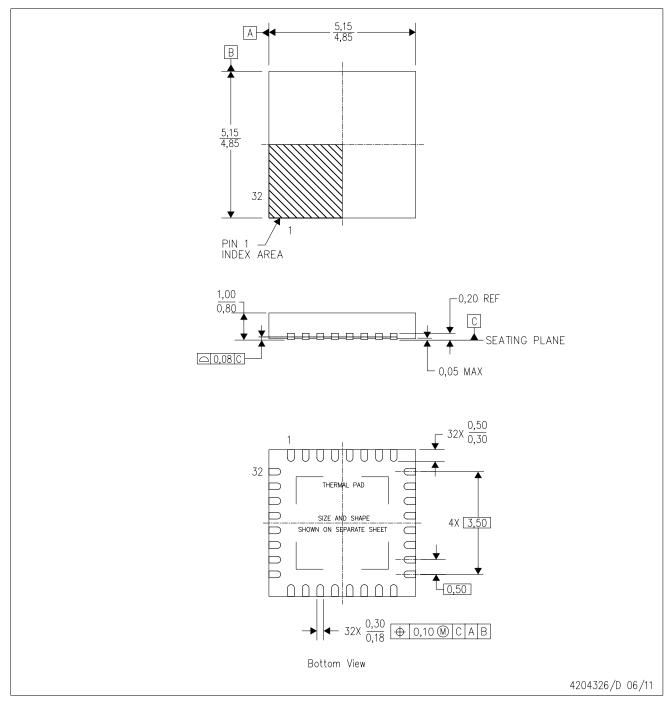


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
PCM3793ARHBR	VQFN	RHB	32	3000	367.0	367.0	35.0
PCM3793ARHBT	VQFN	RHB	32	250	210.0	185.0	35.0
PCM3794ARHBR	VQFN	RHB	32	3000	367.0	367.0	35.0
PCM3794ARHBT	VQFN	RHB	32	250	210.0	185.0	35.0

RHB (S-PVQFN-N32)

PLASTIC QUAD FLATPACK NO-LEAD



- NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
 - B. This drawing is subject to change without notice.
 - C. QFN (Quad Flatpack No-Lead) Package configuration.
 - D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
 - E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
 - F. Falls within JEDEC MO-220.



RHB (S-PVQFN-N32)

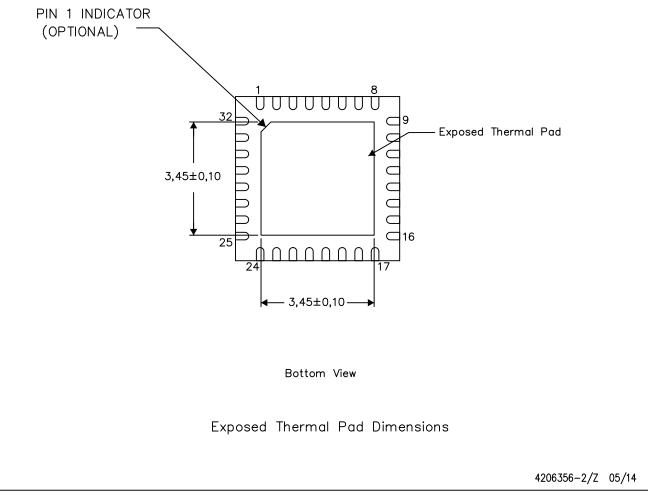
PLASTIC QUAD FLATPACK NO-LEAD

THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No—Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.

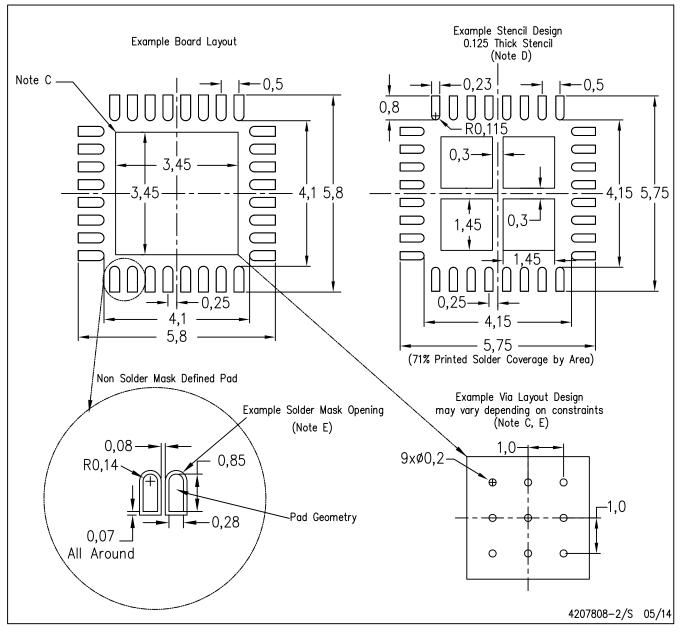


NOTE: A. All linear dimensions are in millimeters



RHB (S-PVQFN-N32)

PLASTIC QUAD FLATPACK NO-LEAD



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat—Pack Packages, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com http://www.ti.com.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- E. Customers should contact their board fabrication site for recommended solder mask tolerances and via tenting recommendations for any larger diameter vias placed in the thermal pad.



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